TEXAS INSTRUMENTS

TPS62770 面向可穿戴应用的多轨 DC/DC 转换器

1 特性

- VIN 范围为 2.5V 至 5.5V
- 370nA Iq 降压转换器
  - 8 个可选输出电压（1.0V 至 3.0V）
  - 300mA 输出电流
  - 输出放电功能
- 受转换率控制的负载开关，具有放电功能
- 双模式降压转换器
  - 负载断开
  - 恒定输出电压，最高可调节至 15V (V_{FB} 0.8 V) /12V（固定值）
  - 发光二极管 (LED) 电流驱动器，提供脉宽调制 (PWM) 用于电流转换（D = 100% 时的最大 V_{FB} 电压为 200mV）
- 超小型 16 引脚 1.58mm x 1.58mm WCSP 封装，0.4mm 间距

2 应用

- 可穿戴和个人电子产品
- 健身配件
- 健康状况监控和医疗配件

3 说明

TPS62770 是一套面向可穿戴 应用 的超小型电源解决方案，其包括一个 370nA 超低 Iq 降压转换器、一个受转换率控制的负载开关以及一个双模式降压转换器。该降压转换器的输出电压可通过三个 VSEL 引脚在 1.0V、1.05V、1.1V、1.2V、1.8V、1.9V、2.0V 和 3.0V 之间选择。可以在运行期间更改输出电压。在关断模式下，该降压转换器的输出拉至 GND。集成的负载开关从内部连接至降压转换器的输出， 并且 接通阶段可控制转换率。关闭后，其输出连接到 GND。

双模式降压转换器既可以生成最高达 15V 的恒定输出电压（例如 PMOLED 电源），也可以提供恒定输出电流（例如 LED 背光电源）。输出电压可通过外部电阻最高调节至 15V，也可以通过将 FB 引脚连接至 VIN 设为 12V 固定电压。该器件 具有 17.7V 内部过压保护，用于 FB 节点悬空或接地情况。该器件包含内部整流器和负载断开功能。用作恒定输出电流驱动器时，该器件可为模拟转换器提供 PWM，以便其根据 PWM 信号的占空比按比例减小基准电压。
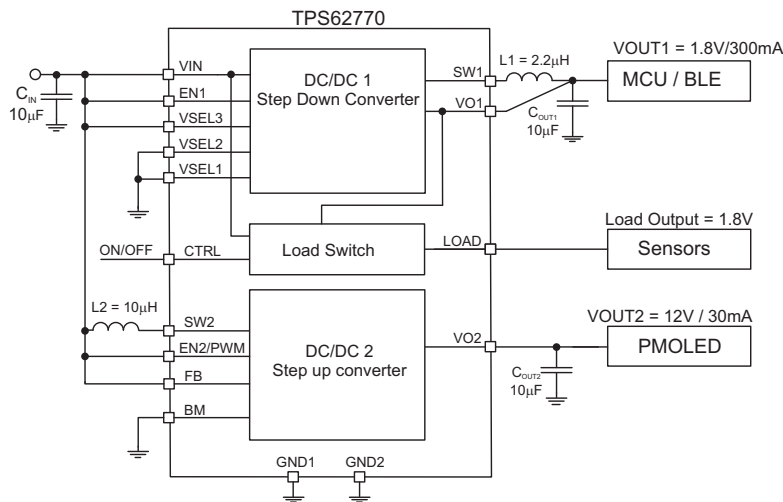
该器件采用小型 16 引脚 0.4mm 间距的 WCSP 封装。

器件信息[1]

器件型号	封装	封装尺寸（标称值）
TPS62770	DSBGA (16)	1.58mm x 1.58mm

(1) 要了解所有可用封装，请见数据表末尾的可订购产品附录。

典型应用电路原理图

目录

4 修订历史记录

Changes from Original (February 2016) to Revision A   **Page**

• 已更改 器件状态至"量产数据"且已发布完整数据表。 1

5 Pin Configuration and Functions

**YFP Package
16-Pin DSBGA
Top View**
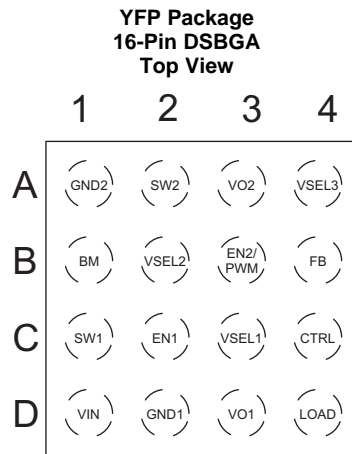
Pin Functions

PIN		I/O	DESCRIPTION
NAME	NO		
EN2/PWM	B3	IN	Enable pin for the step-up converter. High level enables the devices, low level turns the device into shutdown mode. A PWM signal can be applied to this pin when used as a constant current driver (BM pin connected to VIN). The pin must be terminated.
GND2	A1	PWR	GND supply pin for the step-up converter. Connect this pin close to the GND terminals of the input and output capacitors.
SW2	A2	IN	The switch pin of the step-up converter. It is connected to the drain of the internal power MOSFET. Connect the inductor L2 between this pin and the input capacitor CIN
VO2	A3	OUT	Output of the step-up converter.
BM	B1	IN	This pin controls the operation mode of the step-up converter. With BM = high, the device features a low feedback voltage of 200mV, which can be scaled down by the integrated PWM to analog converter. With BM = low, the device operates with a 0.8V feedback voltage and operates as a step-up converter with voltage regulation. This pin must be terminated and set before the device is enabled.
FB	B4	IN	Feedback pin for the step-up converter to set the output voltage / current. Connect the pin to the center tap of a resistor divider to program the output voltage. When it is connected to the VIN pin, the output voltage is set to 12 V by an internal feedback divider network. When used as a LED current driver connect the sense resistor between this pin and GND. The LED string is connected between FB pin and VO2.
EN1	C2	IN	Enable pin for the step-down converter. High level enables the devices, low level turns the device into shutdown mode. The pin must be terminated.
VSEL1	C3	IN	Output voltage selection pins. See Table 1 for V_{OUT} selection. These pins must be terminated. The pins can be dynamically changed during operation.
VSEL2	B2	IN	
VSEL3	A4	IN	
CTRL	C4	IN	This pin controls the load switch between VO1 and LOAD. With CTRL = low, the LOAD switch is disabled. The pin must be terminated.
VIN	D1	PWR	VIN power supply pin. Connect the input capacitor close to this pin for best noise and voltage spike suppression. A ceramic capacitor of 10µF is required.
GND1	D2	PWR	GND supply pin for the step-down converter. Connect this pin close to both, the GND terminal of the input and output capacitor.
SW1	C1	OUT	This is the switch pin of the step-down converter and is connected to the internal MOSFET switches. Connect the inductor L1 between this terminal and the output capacitor.
VO1	D3	OUT	Output of the step-down converter. The output voltage is sensed via this pin to the internal feedback divider network for the regulation loop. In addition the internal load switch is connected between VO1 pin and LOAD pin. Connect this pin directly to the output capacitor with a short trace. The pin is connected to GND1 and discharges the output capacitor when the converter is disabled.
LOAD	D4	OUT	Output terminal of the internal load switch. With CTRL = high, the internal load switch connects VO1 to the LOAD pin. The switch features a slew rate control. This pin is pulled to GND with the CTRL = low. If not used, leave the pin open.

Table 1. Output Voltage Setting Step-Down Converter

VO1 [V]	VSEL3	VSEL2	VSEL1
1.0	0	0	0
1.05	0	0	1
1.1	0	1	0
1.2	0	1	1
1.8	1	0	0
1.9	1	0	1
2.0	1	1	0
3.0	1	1	1

6 Specifications

6.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted) [1]

		MIN	MAX	UNIT
Pin voltage [2]	VIN, FB	−0.3	6	V
	SW1	−0.3	V_{IN} +0.3V	V
	EN1, EN2/PWM, CTRL, BM, VSEL1-3	−0.3	V_{IN} +0.3V	V
	SW2, VO2	-0.3	32	V
	VO1, LOAD	−0.3	3.7	V
T_J	Operating junction temperature range	−40	125	°C
T_{stg}	Storage temperature range	−65	150	°C

(1) Stresses beyond those listed under *absolute maximum ratings* may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under *recommended operating conditions* is not implied. Exposure to absolute–maximum–rated conditions for extended periods may affect device reliability.
(2) All voltage values are with respect to network ground terminal GND.

6.2 ESD Ratings

			VALUE	UNIT
$V_{(ESD)}$	Electrostatic discharge	Human body model (HBM), per ANSI/ESDA/JEDEC JS-001, all pins [1]	± 2000	V
		Charged device model (CDM), per JEDEC specification JESD22-C101, all pins [2]	±500	

(1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process. The human body model is a 100-pF capacitor discharged through a 1.5-kΩ resistor into each pin.
(2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

6.3 Recommended Operating Conditions

			MIN	NOM	MAX	UNIT
V_{IN}	Input voltage range at VIN pin		2.5		5.5	V
I_{OUT1}	DC/DC 1 Step down converter output current	L1 = 2.2µH, C_{OUT1} = 10 µF			300	mA
I_{OUT2}	DC/DC 2 Step up converter output current	2.5V < VIN < 5.5V, VOUT2 = 12V, C_{OUT2} = 10uF, L = 10µH			30	mA
		2.5V < VIN < 5.5V, VOUT2 = 12V, C_{OUT2} = 2x 10uF, L = 10µH			100	
		3V < VIN < 5.5V, VOUT2 = 5V, C_{OUT2} = 2x 10uF, L = 4.7µH			200	
I_{LOAD}	Load current (current from LOAD pin)				100	
T_J	Operating junction temperature range		-40		125	°C
T_A	Ambient temperature range		-40		85	

6.4 Thermal Information

		TPS62770	
	THERMAL METRIC[1]	YFP	UNIT
		TERMINALS	
$R_{\theta JA}$	Junction-to-ambient thermal resistance	90.6	°C/W
$R_{\theta JCtop}$	Junction-to-case (top) thermal resistance	0.6	
$R_{\theta JB}$	Junction-to-board thermal resistance	13.8	
ψ_{JT}	Junction-to-top characterization parameter	2.8	
ψ_{JB}	Junction-to-board characterization parameter	13.7	
$R_{\theta JCbot}$	Junction-to-case (bottom) thermal resistance	n/a	

(1) For more information about traditional and new thermal metrics, see the *Semiconductor and IC Package Thermal Metrics* application report, SPRA953.

6.5 Electrical Characteristics

V_{IN} = 3.6V, T_A = –40°C to 85°C typical values are at T_A = 25°C (unless otherwise noted)

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
SUPPLY						
I_{SD}	Shutdown current into V_{IN}	EN1 = EN2/PWM = GND, CTRL GND, BM = GND,		0.1	1850	nA
V_{TH_UVLO+}	Undervoltage lockout threshold	Rising V_{IN}		2.1	2.22	V
V_{TH_UVLO-}		Falling V_{IN}		1.9	2	
INPUTS EN1, EN2/PWM, BM, CTRL,VSEL 1-3						
$V_{IH\ TH}$	High level input threshold				1.2	V
$V_{IL\ TH}$	Low level input threshold		0.4			V
I_{IN}	Input bias Current	T_J = 25°C			10	nA
		T_J = –40°C to 85°C			25	

Electrical Characteristics (continued)

V_{IN} = 3.6V, T_A = −40°C to 85°C typical values are at T_A = 25°C (unless otherwise noted)

PARAMETER		TEST CONDITIONS		MIN	TYP	MAX	UNIT
STEP-DOWN CONVERTER							
I_Q	Operating quiescent current	EN1 = V_{IN}, EN2/PWM = GND, CTRL = GND, I_{OUT} = 0µA, V_{OUT} = 1.8V, device not switching,			370	1850	nA
		EN1 = V_{IN}, EN2/PWM = GND, I_{OUT} = 0mA, CTRL = GND, V_{OUT} = 1.8V , device switching			500		
V_{VOUT}	Output voltage range			1.0		3.0	V
	Output voltage accuracy	PFM mode		-2.5	0	2.5	%
		PWM mode		-2	0	2	
	DC output voltage load regulation	V_{OUT} = 1.8V			0.001		%/mA
	DC output voltage line regulation	V_{OUT} = 1.8V, I_{OUT} = 10 mA, 2.5V ≤ V_{IN} ≤ 5.5V			0		%/V
$R_{DS(ON)}$	High side MOSFET on-resistance	I_{OUT} = 50mA			0.45		Ω
	Low Side MOSFET on-resistance				0.22		
I_{LIMF}	High side MOSFET switch current limit			480	600	720	mA
	Low side MOSFET switch current limit				600		mA
R_{DSCH_VO1}	Discharge switch on-resistance	EN = GND, I_{VO1} = -10mA into VO1 pin			20	65	Ω
I_{IN_VO1}	Bias current into VO1 pin	EN = V_{IN}, V_{OUT} = 1.8V	T_J = 25°C		40	100	nA
			T_J = −40°C to 85°C			1010	
V_{TH_100+}	Auto 100% Mode leave detection threshold [1]	Rising V_{IN},100% Mode is left with V_{IN} = V_{OUT} + V_{TH_100+} , max value at T_J = 85°C		150	250	370	mV
V_{TH_100-}	Auto 100% Mode enter detection threshold [1]	Falling V_{IN}, 100% Mode is entered with V_{IN} = V_{OUT} + V_{TH_100-}, max value at T_J = 85°C		85	200	310	
t_{ONmin}	Minimum ON time	V_{OUT} = 2.0V, I_{OUT} = 0 mA			225		ns
t_{OFFmin}	Minimum OFF time				50		ns
$t_{Startup\_delay}$	Regulator start up delay time	From transition EN1 = low to high until device starts switching			1	5	ms
$t_{Softstart}$	Softstart time with reduced switch current limit				700	1200	µs
$I_{LIM\_softstart}$	High side MOSFET switch current limit	Reduced switch current limit during softstart		80	150	200	mA
	Low side MOSFET switch current limit				150		
LOAD SWITCH							
R_{LOAD}	MOSFET on-resistance	I_{LOAD} = 50mA, CTRL = V_{IN}, V_{OUT} = 1.8V,			0.6	1.27	Ω
t_{rise_LOAD}	V_{LOAD} rise time	Starting with CTRL low to high transition, time to ramp V_{LOAD} from 95%, V_{OUT} = 1.8V, I_{LOAD} = 20mA			315	800	µs
R_{DCHRG}	MOSFET on-resistance				20	65	Ω

(1) V_{IN} is compared to the programmed output voltage (V_{OUT}). When V_{IN}–V_{OUT} falls below V_{TH_100-} the device enters 100% Mode by turning the high side MOSFET on. The 100% Mode is exited when V_{IN}–V_{OUT} exceeds V_{TH_100+} and the device starts switching. The hysteresis for the 100% Mode detection threshold V_{TH_100+} - V_{TH_100-} will always be positive and will be approximately 50 mV(typ.)

Electrical Characteristics (continued)

V_{IN} = 3.6V, T_A = –40°C to 85°C typical values are at T_A = 25°C (unless otherwise noted)

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
STEP-UP CONVERTER						
I_{Q_VIN}	Quiescent current into VIN pin	EN2/PWM = VIN, BM = GND, EN1 = GND, no load, no switching, V_{OUT} = 12 V		110	200	µA
V_{OUT}	Output voltage range	EN2/PWM = VIN, BM = GND	4.5		15	V
V_{OUT_12V}	12-V output voltage accuracy	FB pin connected to VIN pin, EN2/PWM = V_{IN}, BM = GND	11.7	12	12.3	V
V_{FB}	Feedback voltage	PWM mode, BM = GND, EN2/PWM = V_{IN}	0.775	0.795	0.814	V
		PFM mode, BM = GND, EN2/PWM = V_{IN}		0.803		V
	Feedback regulation voltage under brightness control	EN2/PWM = VIN, BM = VIN,	189	200	206	mV
		VFB =50mV, BM = VIN, D(PWM) @ EN2/PWM = 25%,	40	50	60	mV
		VFB = 20mV, BM = VIN, D(PWM) @ EN2/PWM = 10%	13	20	27	
t_{Dim_Off}	Dimming signal on pin EN2/PWM			270	160	µs
t_{Dim_On}			1			µs
V_{OVP}	Output overvoltage protection threshold		17	17.7	18.4	V
V_{OVP_HYS}	Over voltage protection hysteresis			800		mV
I_{FB_LKG}	Leakage current into FB pin			5	200	nA
I_{SW_LKG}	Leakage current into SW pin	EN2/PWM = GND		5	500	nA
$R_{DS(on)}$	Isolation MOSFET on resistance	V_{OUT} = 12 V		850		mΩ
	Low-side MOSFET on resistance	V_{OUT} = 12 V		450		
f_{SW}	Switching frequency	V_{OUT} = 12 V, PWM mode	850	1050	1250	kHz
t_{ON_min}	Minimal switch on time			150	250	ns
I_{LIM_SW}	Peak switch current limit	V_{OUT} = 12 V	730	970	1230	mA
I_{LIM_CHG}	Pre-charge current	V_{OUT} = 0 V		30	55	mA
$t_{Softstart}$	Pre-charge time	BM = GND, EN2/PWM from low to high until device starts switching, I_{OUT2} = 0mA, C_{OUT2} = 10uF		6		ms
	Startup time	V_{OUT} from V_{IN} to 12 V, $C_{OUT\_effective}$ = 2.2 µF, I_{OUT} = 0 A		6		

6.6 Typical Characteristics

EN2/PWM = low   VOUT1 set to 1.8V

EN1 = high   device not switching
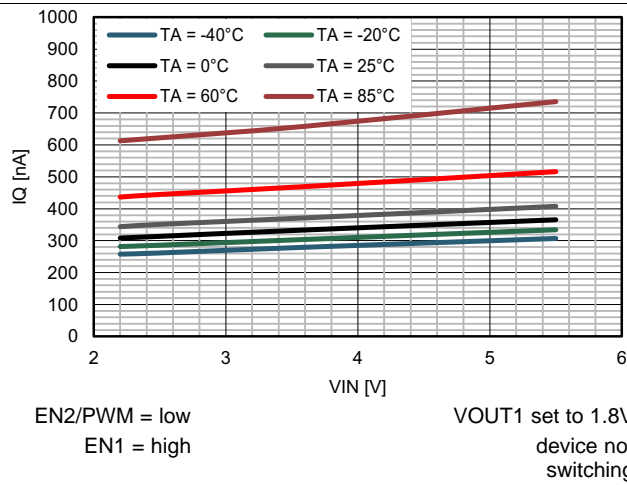
图 1. Quiescent current I$_Q$ Step-Down converter

EN2/PWM = high   VOUT2 set to 12V

EN1 = low   device not switching
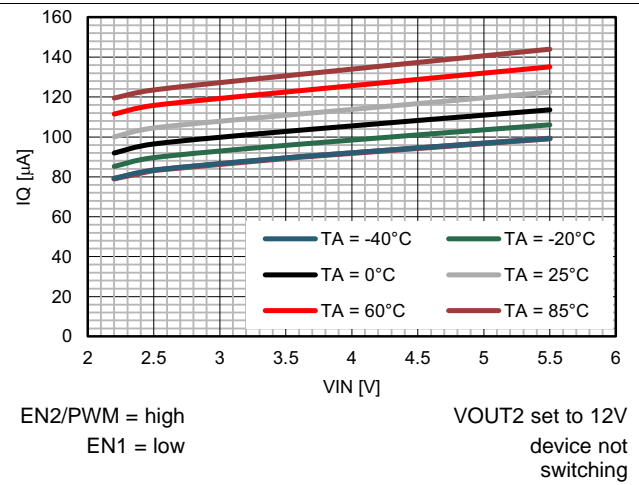
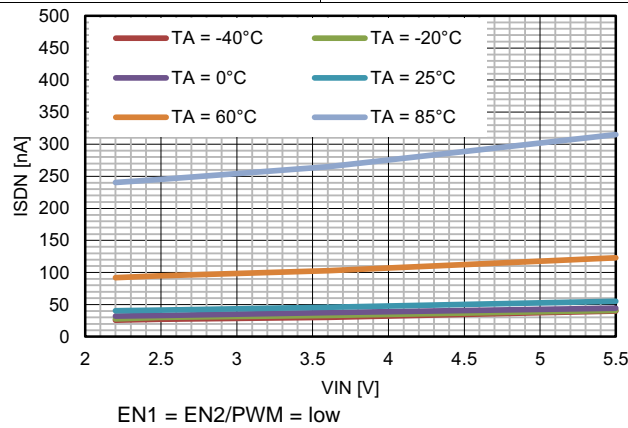图 2. Quiescent current I$_Q$ Step-Up converter

EN1 = EN2/PWM = low

图 3. Shutdown current I$_{SDN}$

7 Detailed Description

7.1 Overview

The TPS62770 is a tiny power solution for wearable applications including a 370nA ultra low Iq step-down converter, a slew rate controlled load switch and a dual mode step-up converter. The output voltage of the step-down converter can be selected with three VSEL pins between 1.0 V, 1.05 V, 1.1 V, 1.2 V, 1.8 V, 1.9 V, 2.0 V and 3.0 V.

The dual mode step-up converter can generate a constant output voltage up to 15 V, such as PMOLED supply or, a constant output current, such as LED back light supply.

7.2 Functional Block Diagram
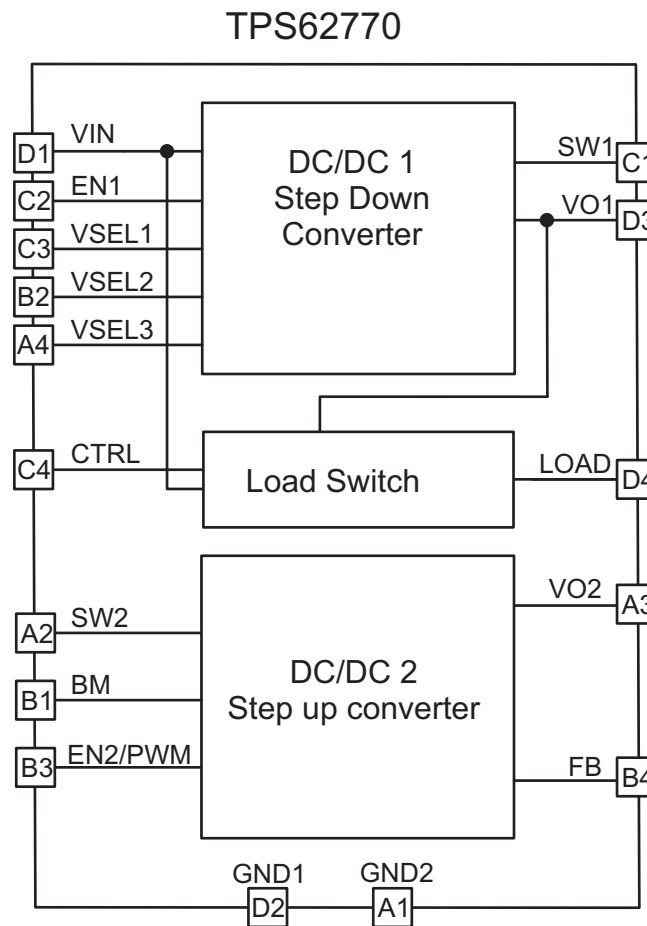
7.3 Feature Description

7.3.1 Step-Down Converter Device
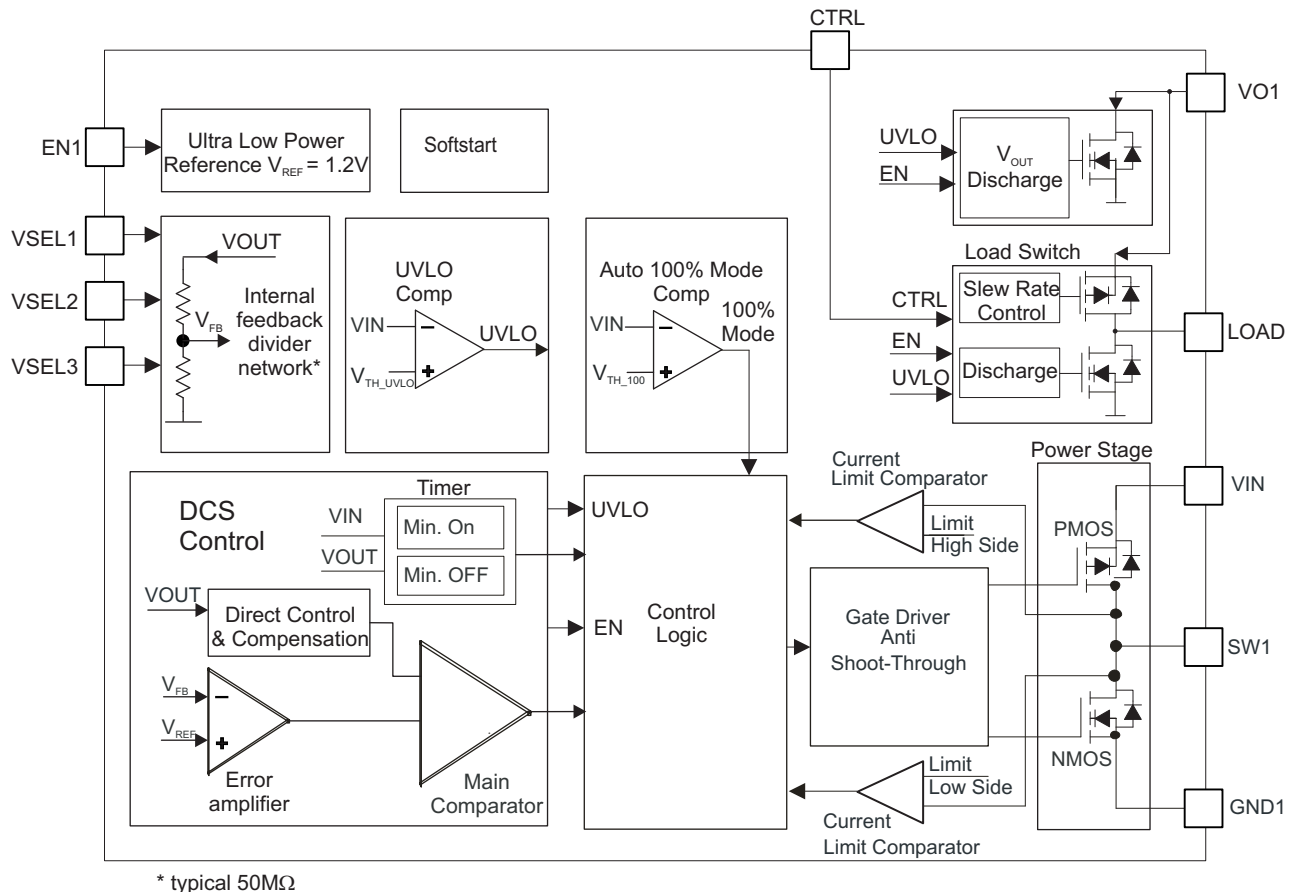
图 4. **Block diagram Step-Down Converter with Load Switch**

7.3.1.1 *DCS-Control™*

TI's DCS-Control™ (Direct Control with Seamless Transition into Power Save Mode) is an advanced regulation topology, which combines the advantages of hysteretic and voltage mode control. Characteristics of DCS-Control™ are excellent AC load regulation and transient response, low output ripple voltage and a seamless transition between PFM and PWM mode operation. DCS-Control™ includes an AC loop which senses the output voltage (VO1 pin) and directly feeds the information to a fast comparator stage. This comparator sets the switching frequency, which is constant for steady state operating conditions, and provides immediate response to dynamic load changes. In order to achieve accurate DC load regulation, a voltage feedback loop is used. The internally compensated regulation network achieves fast and stable operation with small external components and low ESR capacitors. The DCS-Control™ topology supports PWM (Pulse Width Modulation) mode for medium and high load conditions and a Power Save Mode at light loads. Since DCS-Control™ supports both operation modes within one single building block, the transition from PWM to Power Save Mode is seamless with minimum output voltage ripple. The step-down converter offers both excellent DC voltage and superior load transient regulation, combined with low output voltage ripple, minimizing interference with RF circuits.

7.3.1.2 *Output Voltage Selection with pins VSEL1-VSEL3*

The step-down converter doesn't require an external resistor divider network to program the output voltage. The device integrates a high impedance feedback resistor divider network that is programmed by the pins VSEL1-3. It supports an output voltage range from 1.0 V to 3.0 V. The output voltage is programmed according to Table 1 . The output voltage can be changed during operation. This can be used for simple dynamic output voltage scaling.

Feature Description (接下页)

7.3.1.3 CTRL / Output Load

With the CTRL pin set to high, the integrated loadswitch is activated and connects the LOAD pin to the VO1 pin to power up an additional sub-system. The load switch is slew rate controlled to support soft switching and not to impact the regulated output VO1. If CTRL pin is pulled to GND, the LOAD pin is disconnected from the VO1 pin and internally connected to GND by an internal discharge switch. The CTRL pin can be controlled by a micro controller.

7.3.1.4 Output Discharge At Pins VO1 And LOAD

Both the VO1 pin and the LOAD pin feature a discharge circuit to connect each rail to GND, once they are disabled. This feature prevents residual charge voltages on capacitors connected to these pins, which may impact proper power up of the main- and sub-system. With CTRL pin pulled to low, the discharge circuit at the LOAD pin becomes active. With the EN pin pulled to low, the discharge circuits at both pins VO1 and Load are active. The discharge circuits of both rails VO1 and LOAD are associated with the UVLO comparator as well. Both discharge circuits become active once the input voltage VIN has dropped below the UVLO comparator threshold VTH_UVLO- and the UVLO comparator triggers.

7.3.1.5 Undervoltage Lockout UVLO

The UVLO circuit shuts down the device if the input voltage V_{IN} drops to typical 1.9V. The device will start up at an input voltage of typ. 2.1V.

7.3.1.6 Short Circuit Protection

The step-down converter integrates a current limit on the high side, as well on the low side MOSFETs to protect the device against overload or short circuit conditions. The peak current in the switches is monitored cycle by cycle. If the high side MOSFET current limit is reached, the high side MOSFET is turned off and the low side MOSFET is turned on until the switch current decreases below the low side MOSFET current limit. Once the low side MOSFET current limit trips, the low side MOSFET is turned off and the high side MOSFET turns on again.

Feature Description (接下页)

7.3.2 Step-Up Converter Device
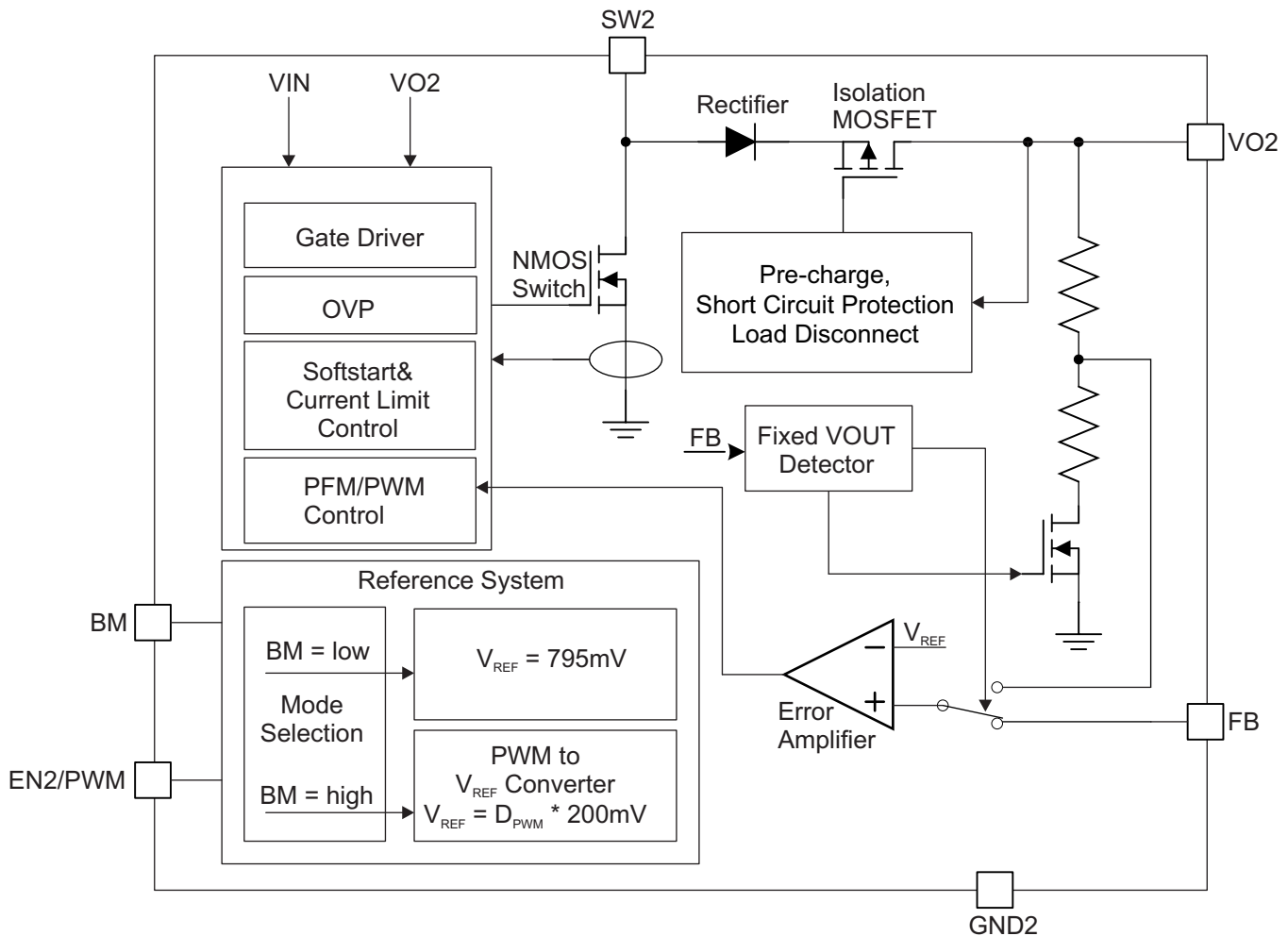
图 5. Block Diagram Step-Up Converter

The step-up converter is designed for applications requiring voltages up to 15V from an Li-Ion battery and tiny solution size such as PMOLED displays or LED back light for small size LCD displays. The step-up converter operates in two different modes, either as constant output voltage step-up converter operating with 0.8V internal reference or as a constant output current step-up converter operating with a reduced internal reference voltage of 200mV. The block integrates power switch, input/output isolation switch, and power diode.

7.3.2.1 Under-Voltage Lockout

See section *Undervoltage Lockout UVLO*

7.3.2.2 Output Disconnect

One common issue with conventional step-up regulators is the conduction path from input to output even when the device is disabled. It creates three problems, which are inrush current during start-up, output leakage current during shutdown and excessive over load current. The step-up converter has an integrated isolation (load disconnect) switch, which is turned off under shutdown mode and over load conditions, thereby opening the current path to the output VO2. Thus the device can truly disconnect the load from the input voltage and minimize the leakage current during shutdown mode.

Feature Description (接下页)

7.3.2.3 12V Fixed Output Voltage

The step-up converter features an internal default 12-V output voltage setting by connecting the FB pin to the VIN pin. Therefore no external resistor divider network is required minimizing the total solution size.

7.3.2.4 Mode Selection With Pin BM

The step-up converter can operate in two different modes. With pin BM = low the device regulates to a constant output voltage, with BM = high, the device can regulate a constant output current. Further details in section *Constant-Current Step-Up Mode Operation* and section *Constant-Voltage Step-Up Mode Operation*. The operation mode need to be selected before the device is enabled. The pin BM may not be changed during operation.

7.3.2.5 Output Overvoltage Protection

When the output voltage exceeds the OVP threshold of 17.7 V, the device stops switching. Once the output voltage falls 0.8 V below the OVP threshold, the device resumes operation again.

7.3.2.6 Output Short Circuit Protection

The step-up converter starts to limit the output current whenever the output voltage drops below 4 V. When the VOUT pin is shorted to ground, the output current is limited. This function protects the device from being damaged when the output is shorted to ground.

7.3.2.7 PWM to Analog Converter AT PIN EN2/PWM

In constant current step-up mode operation two control functions are associated with the pin EN2/PWM:

a) Enable/ disable of the step-up converter

b) PWM to analog conversion to scale the internal reference voltage.

The internal reference voltage scales proportional with the duty cycle of the PWM signal applied at the pin EN2/PWM. More details in section *Constant-Current Step-Up Mode Operation*.

7.4 Device Functional Modes

7.4.1 Step-Down Converter

7.4.1.1 Enable and Shutdown

The step-down converter is turned on with EN1 = high. With EN1 = low the step-down converter is turned off. This pin must be terminated.

7.4.1.2 Power Save Mode Operation

At light loads, the device operates in Power Save Mode. The switching frequency varies linearly with the load current. In Power Save Mode the device operates in PFM (Pulse Frequency Modulation) that generates a single switching pulse to ramp up the inductor current and recharges the output capacitor, followed by a sleep period where most of the internal circuits are shutdown to achieve lowest operating quiescent current. During this time, the load current is supported by the output capacitor. The duration of the sleep period depends on the load current and the inductor peak current. During the sleep periods, the current consumption is reduced to 360 nA. This low quiescent current consumption is achieved by an ultra low power voltage reference, an integrated high impedance feedback divider network and an optimized Power Save Mode operation.

7.4.1.3 PWM Mode Operation

At moderate to heavy load currents, the device operates in PWM mode with continuos conduction. The switching frequency is up to 1.6 MHz with a controlled frequency variation depending on the input voltage and load current. If the load current decreases, the converter seamlessly enters Power Save Mode to maintain high efficiency down to very light loads.

Device Functional Modes (接下页)

7.4.1.4 Device Start-up and Soft Start

The step-down converter has an internal soft start to minimize inrush current and input voltage drop during start-up. Once the device is enabled the device starts switching after a typical delay time of 1 ms. Then the soft start time of typical 700 µs begins with a reduced current limit of typical 150mA. When this time expires the device enters full current limit operation.

7.4.1.5 Automatic Transition Into 100% Mode

Once the input voltage comes close to the output voltage, the DC/DC converter stops switching and enters 100% duty cycle operation. It connects the output V_{OUT} via the inductor and the internal high side MOSFET switch to the input VIN, once the input voltage V_{IN} falls below the 100% mode enter threshold, V_{TH_100-}. The DC/DC regulator is turned off, switching stops and therefore no output voltage ripple is generated. Because the output is connected to the input, the output voltage follows the input voltage minus the voltage drop across the internal high side switch and the inductor. Once the input voltage increases and trips the 100% mode exit threshold, V_{TH_100+} , the DC/DC regulator turns on and starts switching again.

7.4.2 Step-Up Converter

7.4.2.1 Enable and Shutdown

The device is turned on with EN2/PWM = high. With EN2/PWM = low the device enters shutdown mode. In constant current step-up mode (BM = high) the pin EN2/PWM has to be pulled to low level for longer than t_{Dim_Off} max to enter shutdown mode. This pin must be terminated.

7.4.2.2 Soft Start

The step-up converter begins soft start when the EN2/PWM pin is pulled high. At the beginning of the soft start period, the isolation FET is turned on slowly to charge the output capacitor with 30-mA current for about 6 ms. This is called the pre-charge phase. The output is charged up to the level of the input voltage VIN. After the pre-charge phase, the device starts switching and the output voltage ramps up. This is called switching soft start phase. An internal soft start circuit limits the peak inductor current.

7.4.2.3 Power Save Mode

The step-up converter integrates a power save mode with pulse frequency modulation (PFM) to improve efficiency at light load. When the load current decreases, the inductor peak current set by the output of the error amplifier declines to regulate the output voltage. When the inductor peak current hits the low limit of 240 mA, the output voltage will exceed the set voltage as the load current decreases further. The device enters power save mode once the FB voltage exceeds the PFM mode threshold, which is 1% above the nominal output voltage. It stops switching, the load is supplied by the output capacitor and the output voltage begins to decline. When the FB voltage falls below the PFM mode threshold voltage, the device starts switching again to ramp up the output voltage.
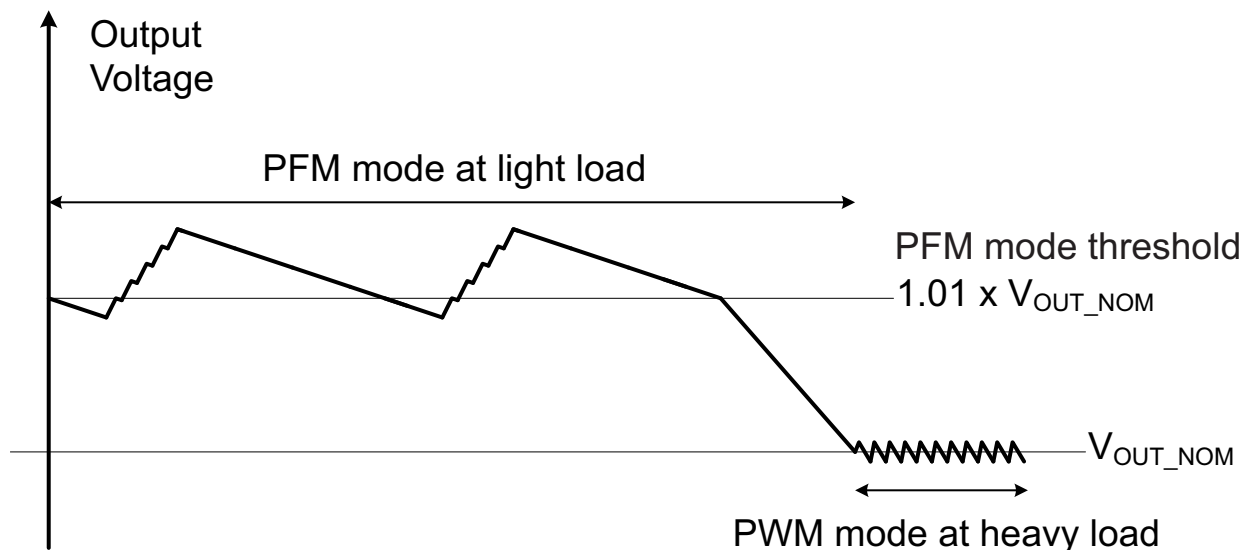
Device Functional Modes (接下页)

图 6. Output Voltage in PFM and PWM Mode

7.4.2.4 PWM Mode

The step-up converter uses a quasi-constant 1.0-MHz frequency pulse width modulation (PWM) at moderate to heavy load current. Based on the input voltage to output voltage ratio, a circuit predicts the required off-time. At the beginning of the switching cycle, the NMOS switching FET is turned on. The input voltage is applied across the inductor and the inductor current ramps up. In this phase, the output capacitor is discharged by the load current. When the inductor current hits the current threshold that is set by the output of the error amplifier, the PWM switch is turned off, and the power diode is forward-biased. The inductor transfers its stored energy to charge the output capacitor and supply the load. When the off-time is expired, the next switching cycle starts again. The error amplifier compares the FB pin voltage with an internal reference voltage, and its output determines the inductor peak current.

7.4.2.5 Constant-Current Step-Up Mode Operation

With pin BM = high the converter can regulate to a constant output current. The internal reference voltage is therefore reduced to 200mV. In order to regulate a constant output current, a sense resistor has to be connected between pin FB and GND, see 图 7. The device features in this operation mode a PWM to analog converter at pin EN2/PWM. The internal reference voltage is scaled according to the duty cycle of the PWM signal applied to pin EN2/PWM, see 图 8. When the pin EN2/PWM is pulled low longer than t_{Dim_OFF} max, the step-up converter enters shutdown mode. The constant output current I_{OUT2} can be calculated according equations 公式 1 and 公式 2.

Device Functional Modes (接下页)
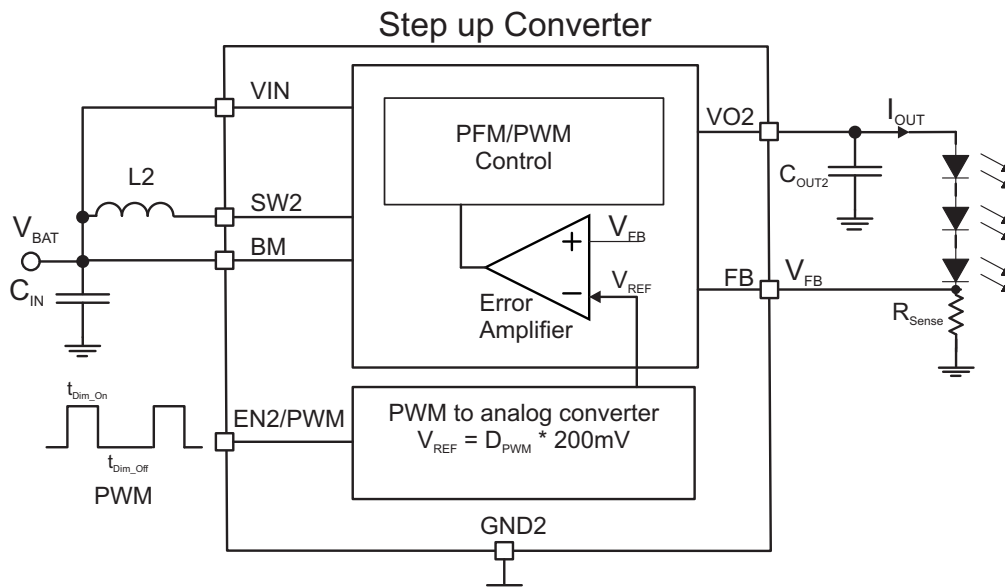
图 7. **Step-Up Converter in Constant-Current Operation Mode**
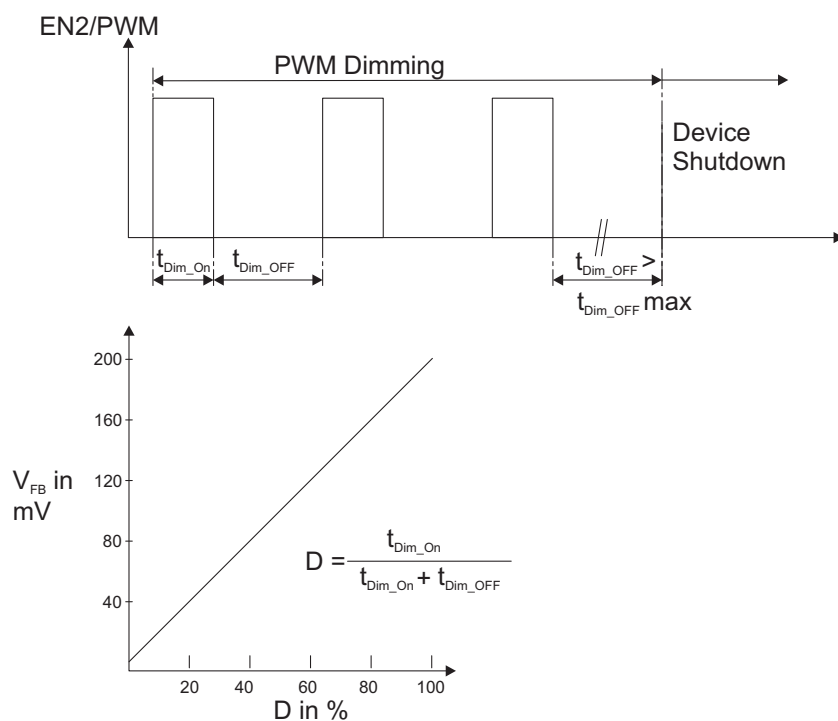
图 8. **EN2/PWM Pin Function**

$$I_{OUT2} = \frac{V_{FB}}{R_{Sense}}$$

(1)

$$I_{OUT2} = D_{PWM} \times \frac{200mV}{R_{Sense}}$$

(2)

Device Functional Modes (接下页)

7.4.2.6 Constant-Voltage Step-Up Mode Operation

With pin BM = low the converter operates as a constant output voltage step-up converter. The internal reference voltage is set to 795 mV. A feedback resistor divider need to be connected between VOUT, FB and GND with its tap point connected to FB pin. The device provides a fixed set 12 V output voltage if the FB pin is connected to VIN. In this case no external resistor divider network is needed.

8 Application and Implementation

> 注
>
> Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

8.1 Application Information

The TPS62770 is a tiny power solution for wearable applications including a 370nA ultra low Iq step-down converter, a slew rate controlled load switch and a dual mode step-up converter. The output voltage of the step-down converter can be selected between 1.0V and 3.0V. The output voltage can be changed during operation. In shutdown mode, the output of the step-down converter is pulled to GND. The integrated load switch is internally connected to the output of the step-down converter and features slew rate control during turn on phase. Once turned off, its output is connected to GND.

The dual mode step-up converter can generate a constant output voltage up to 15V, e.g. for PMOLED supply, or a constant output current, e.g. for LED back light supply. The output voltage can be adjusted up to 15V with external resistors, or set to fixed 12V by connecting the FB pin to VIN. The device features an internal over voltage protection of 17V in case the FB node is left open or tight to GND. It includes an internal rectifier and load disconnect function. When used as constant output current driver, the device offers a PWM to analog converter to scale down the reference voltage according to the duty cycle of the PWM signal.

8.2 Typical Application

8.2.1 System and PMOLED Supply
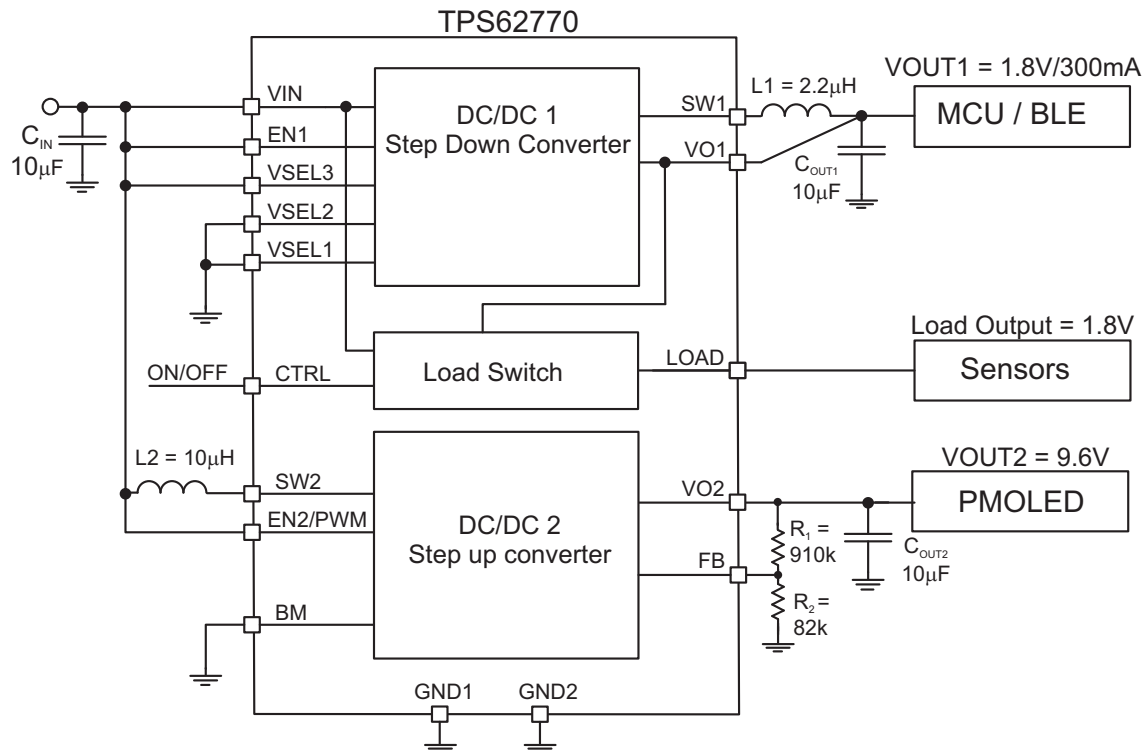
图 **9. Step-Up Converter with Adjustable Output Voltage**

Typical Application (接下页)
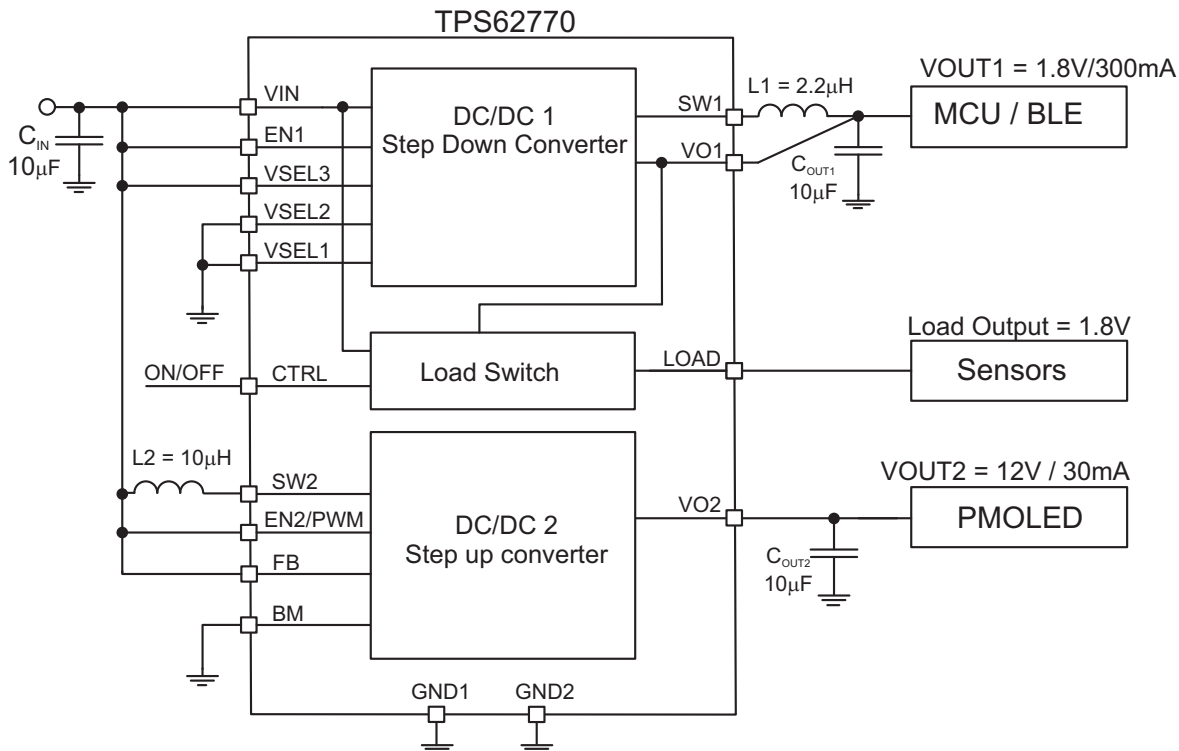
图 10. Step-Up Converter with Fixed 12-V Output

8.2.1.1 Design Requirements

The device is supplied by an input voltage between 2.5V and 5.5V. In wearable personal electronics this is usually a rechargeable Li-Ion battery / USB port. The step-down converter supplies the system (MCU/BLE radio). In order to supply a PMOLED display, the step-up converter must be configured to operate in constant output voltage mode with BM pin tied to GND before the step-up converter is enabled. Ideally the BM pin is hardwired to GND. The output voltage of the step-up converter is either set by an external resistor divider network (R1/R2), shown in 图 9. The step-up converter supports an internally fixed 12V output voltage by connecting the FB pin to VIN, shown in 图 10.

The LOAD output is internally connected to the output of the buck regulator and can supply a sensor or a sub-system, which are temporarily used. In order to achieve better supply voltage decoupling / noise reduction a capacitor can be connected on the LOAD output.

The design guideline provides a component selection to operate the device within the recommended operating conditions. 表 2 shows the components used for the application characteristic curves.

表 2. Components for Application Characteristic Curves

REFERENCE	DESCRIPTION	VALUE	PACKAGE CODE / SIZE [mm x mm x mm]	MANUFACTURER
CIN	Ceramic capacitor X5R 6.3V, GRM155R60J106ME11	10 µF	0402 / 1.0 x 0.5 x 0.5	Murata
COUT1	Ceramic capacitor X5R 6.3V, GRM155R60J106ME11	10 µF	0402 / 1.0 x 0.5 x 0.5	Murata
COUT2	Ceramic capacitor X5R 25V, GRM188R61E106MA73	10 uF	0603 / 1.6 x 0.8 x 0.8	Murata
L1	Inductor DFE201610C	2.2 µH	2.0 x 1.6 x 1.0	Toko
L2	Inductor VLS302515	10 µH	3.0 x 2.5 x 1.5	TDK

8.2.1.2 Application Curves Step-Down Converter
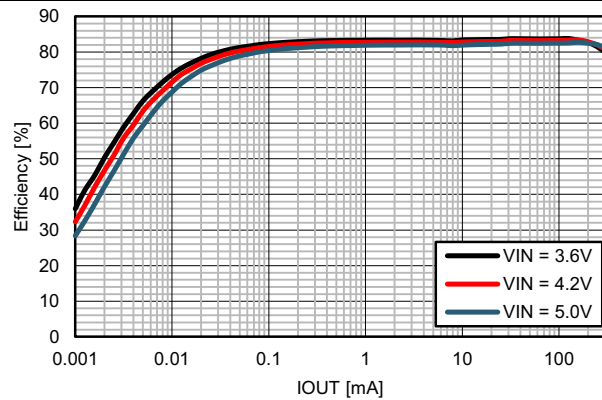
图 11. Efficiency vs. IOUT, VOUT1 = 1.0 V
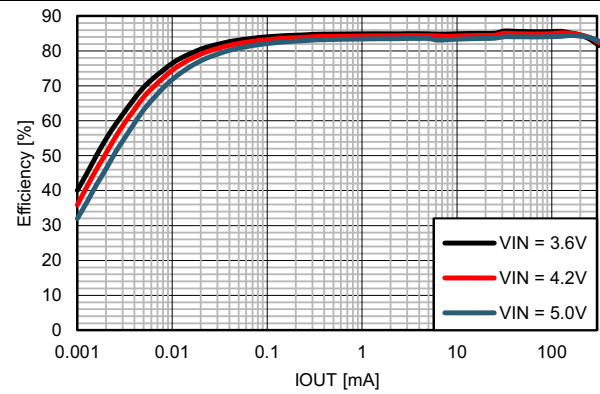
图 12. Efficiency vs. IOUT, VOUT1 = 1.2 V
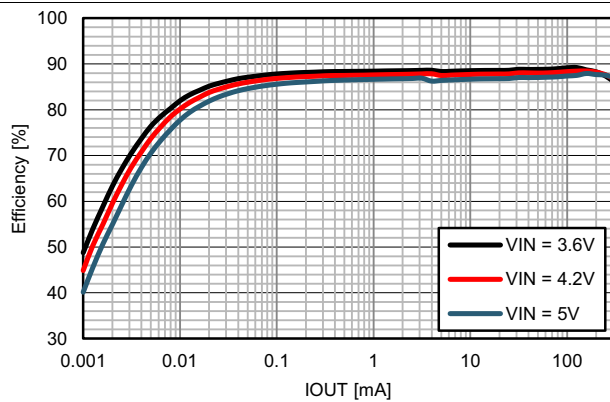
图 13. Efficiency vs. IOUT, VOUT1 = 1.8 V
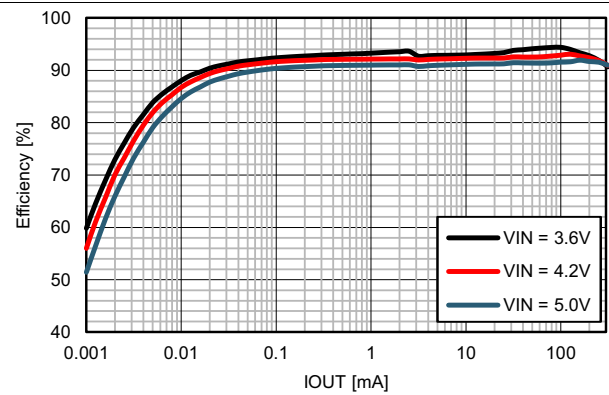
图 14. Efficiency vs. IOUT, VOUT1 = 3.0 V
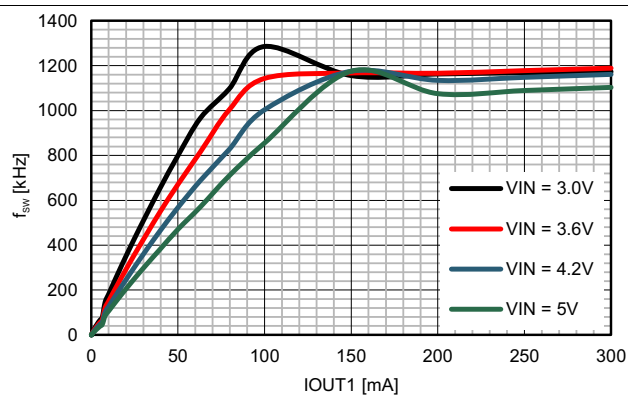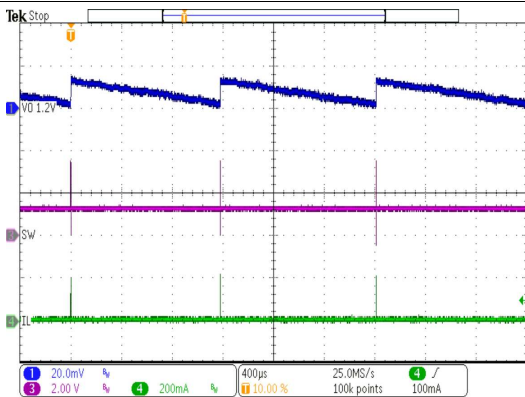

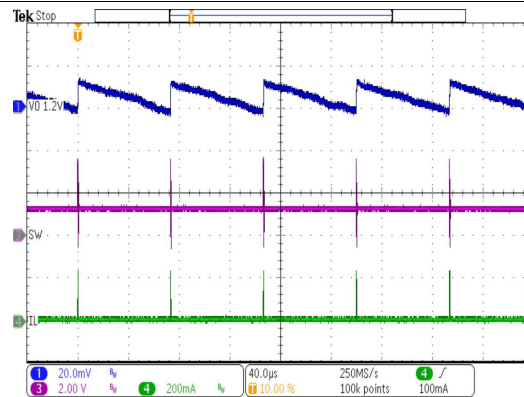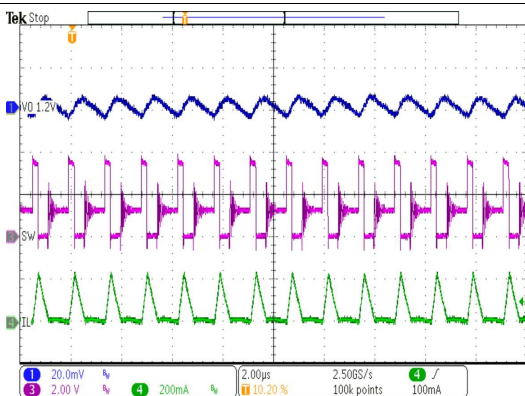图 15. F$_{SW}$ vs. IOUT1, VOUT1 = 1.1 V
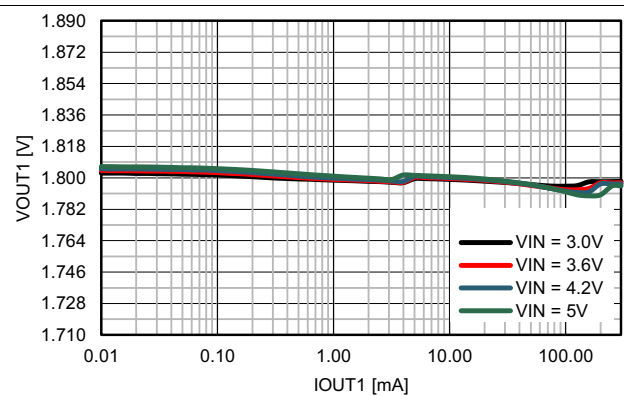
图 16. VOUT1 = 1.8 V vs IOUT1

V_{IN} = 3.6V I_{OUT} = 50 µA
V_{OUT} = 1.2V

图 17. Typical Operation in Power Save Mode

V_{IN} = 3.6V I_{OUT} = 1 mA
V_{OUT} = 1.2V

图 18. Typical Operation in Power Save Mode

V_{IN} = 3.6V I_{OUT} = 50 mA
V_{OUT} = 1.2V

图 19. Typical Operation in Power Save Mode
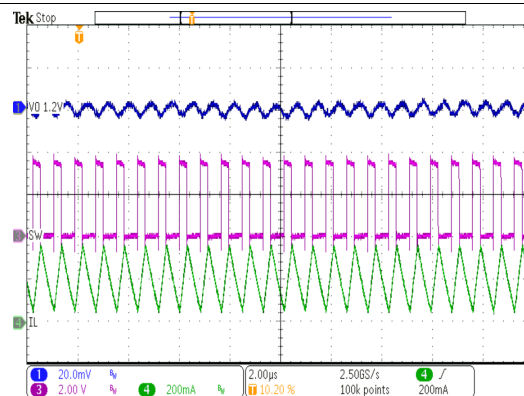
V_{IN} = 3.6V I_{OUT} = 200 mA
V_{OUT} = 1.2V

图 20. Typical Operation in PWM Mode
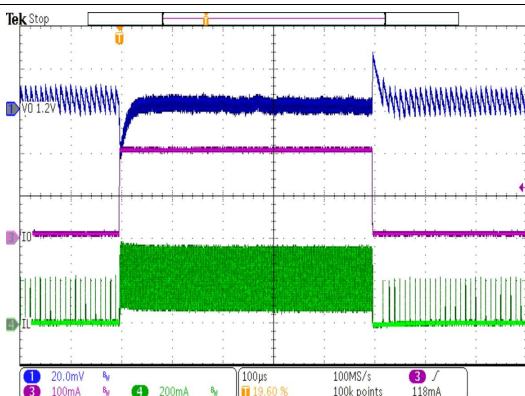
V_{IN} = 3.6V I_{OUT} = 5mA to 200mA
V_{OUT} = 1.2V   1 µs rise/fall time

图 21. Load Transient Performance
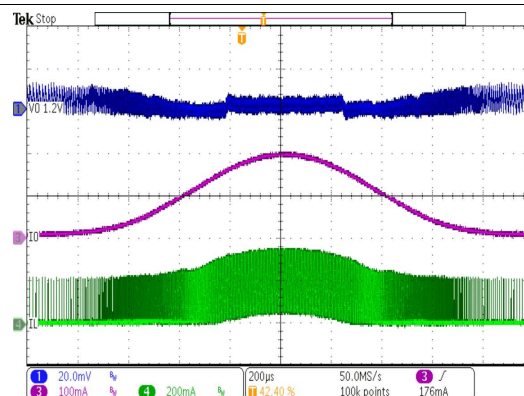
V_{IN} = 3.6V I_{OUT} = 5mA to 200mA
V_{OUT} = 1.2V   sinusodial I_{OUT} sweep

图 22. AC Load Regulation Performance
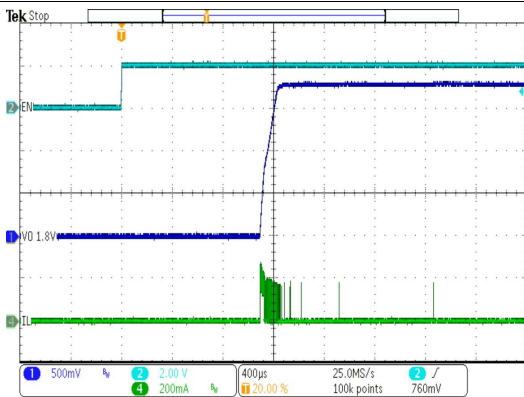
V_{IN} = 3.6V　　　　　　　　　　I_{OUT} = 0mA
V_{OUT} = 1.8V

图 23. Startup After EN High
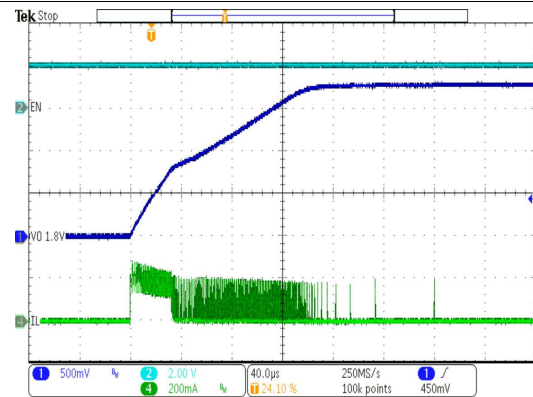
V_{IN} = 3.6V　　　　　　　　　　I_{OUT} = 0mA
V_{OUT} = 1.8V　　　　　EN altered from low to high
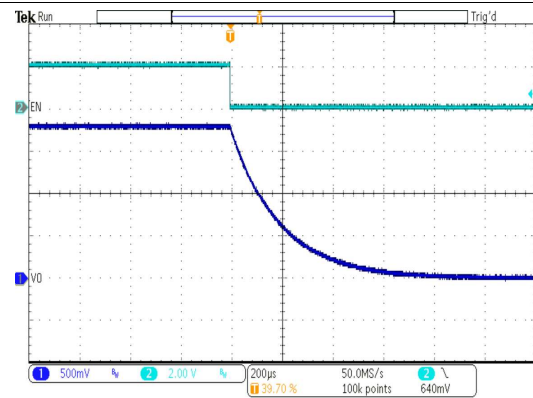
图 24. VOUT Ramp Up
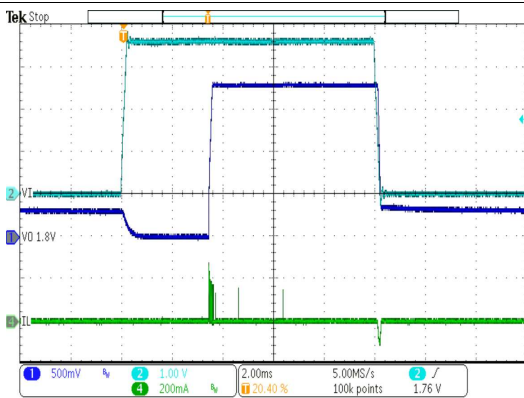
V_{IN} = 0 V to 3.6 V　　　　　　　　EN = VIN
　　　in 100 µs
V_{OUT} = 1.8V　　　　　　　　I_{OUT} = 0 mA

图 25. VIN Ramp Up/Down

V_{IN} = 3.6V　　　　　　　　　　I_{OUT} = 0mA
V_{OUT} = 1.8V

图 26. Output Discharge
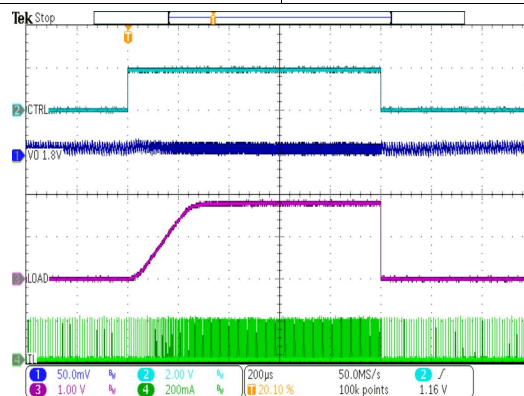
V_{IN} = 3.6V　　　　　　　　I_{OUT1} = 5mA
V_{OUT} = 1.8V　　　　　　　R_{LOAD} = 150Ω

图 27. Output Load Enable/Disable

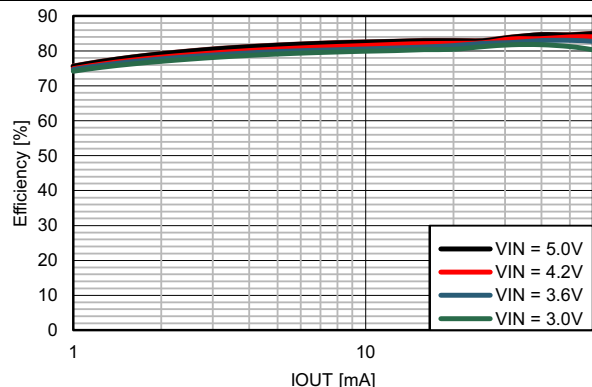### 8.2.1.3 Application Curves Step-Up Converter Constant 12 V/15 V Output Voltage
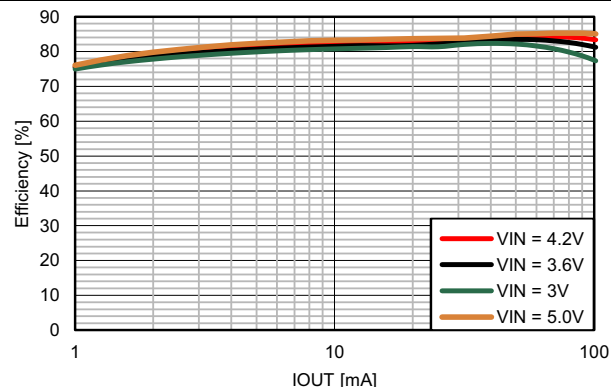
图 28. Efficiency vs. IOUT, VOUT = 15V

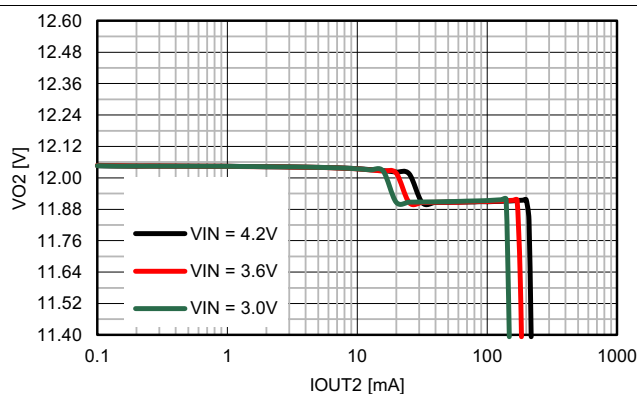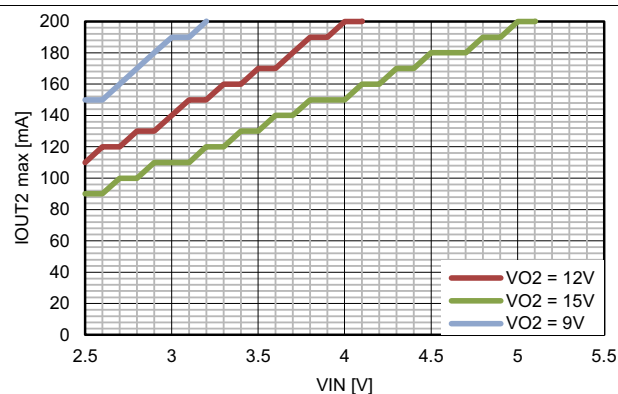图 29. Efficiency vs. IOUT, VOUT = 12V

图 30. VOUT2 = 12V vs IOUT2

TA = 25°C
L = 10µH

typical switch current lmit I$_{LIM\_SW}$
I$_{OUT2}$ max @ -3% VOUT drop
COUT2 = 2x 10µF
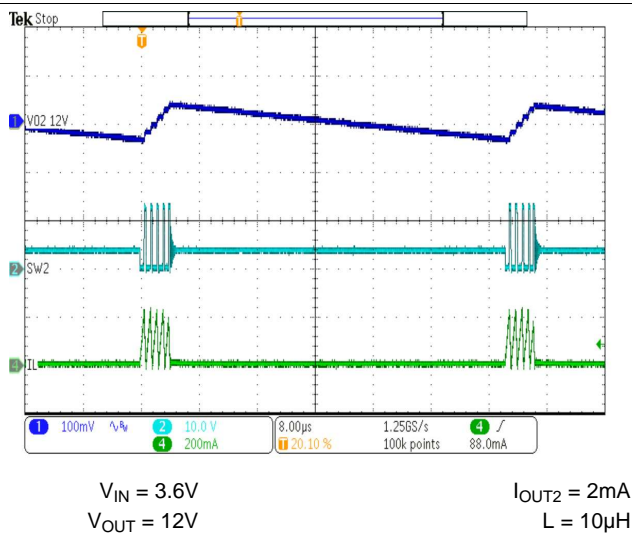
图 31. Maximum Output Current vs VIN for Typical I$_{LIMSW}$

V$_{IN}$ = 3.6V   I$_{OUT2}$ = 2mA
V$_{OUT}$ = 12V   L = 10µH

图 32. Typical Operation PFM Mode

V$_{IN}$ = 3.6V   I$_{OUT2}$ = 30mA
V$_{OUT}$ = 12V   L = 10µH
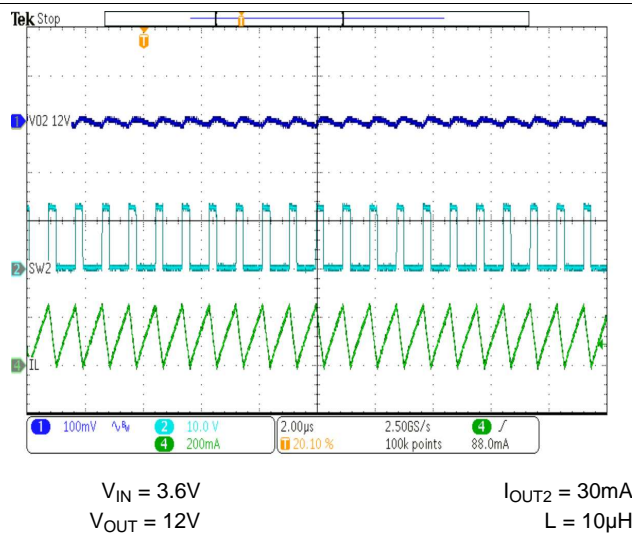
图 33. Typical Operation PWM Mode

V_{IN} = 3.6V	I_{OUT2} = 0 mA to 20 mA
V_{OUT} = 12V	L = 10μH

图 34. AC Load Regulation Performance

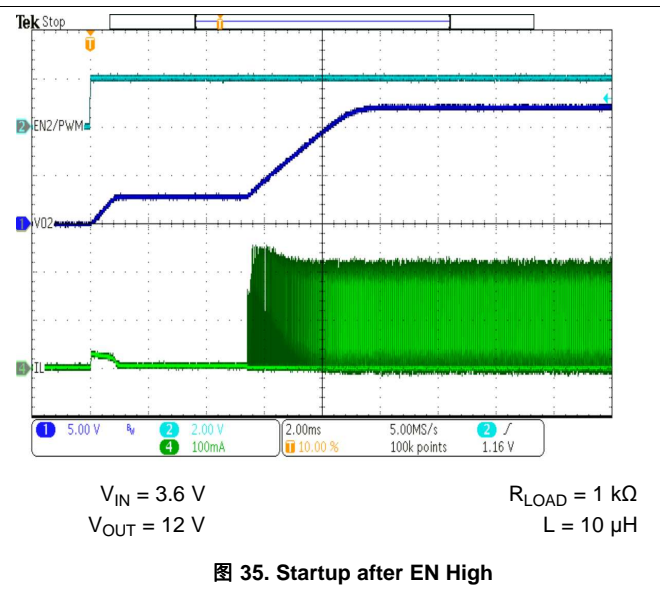| V_{IN} = 3.6 V	R_{LOAD} = 1 kΩ
V_{OUT} = 12 V	L = 10 μH
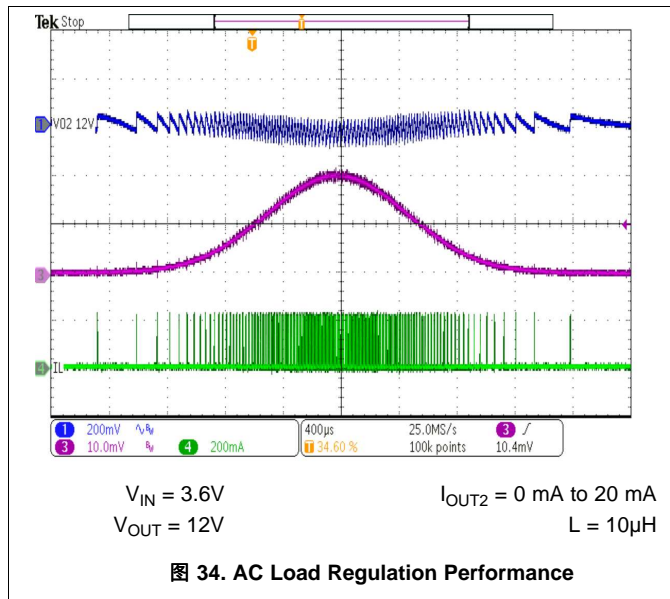
图 35. Startup after EN High

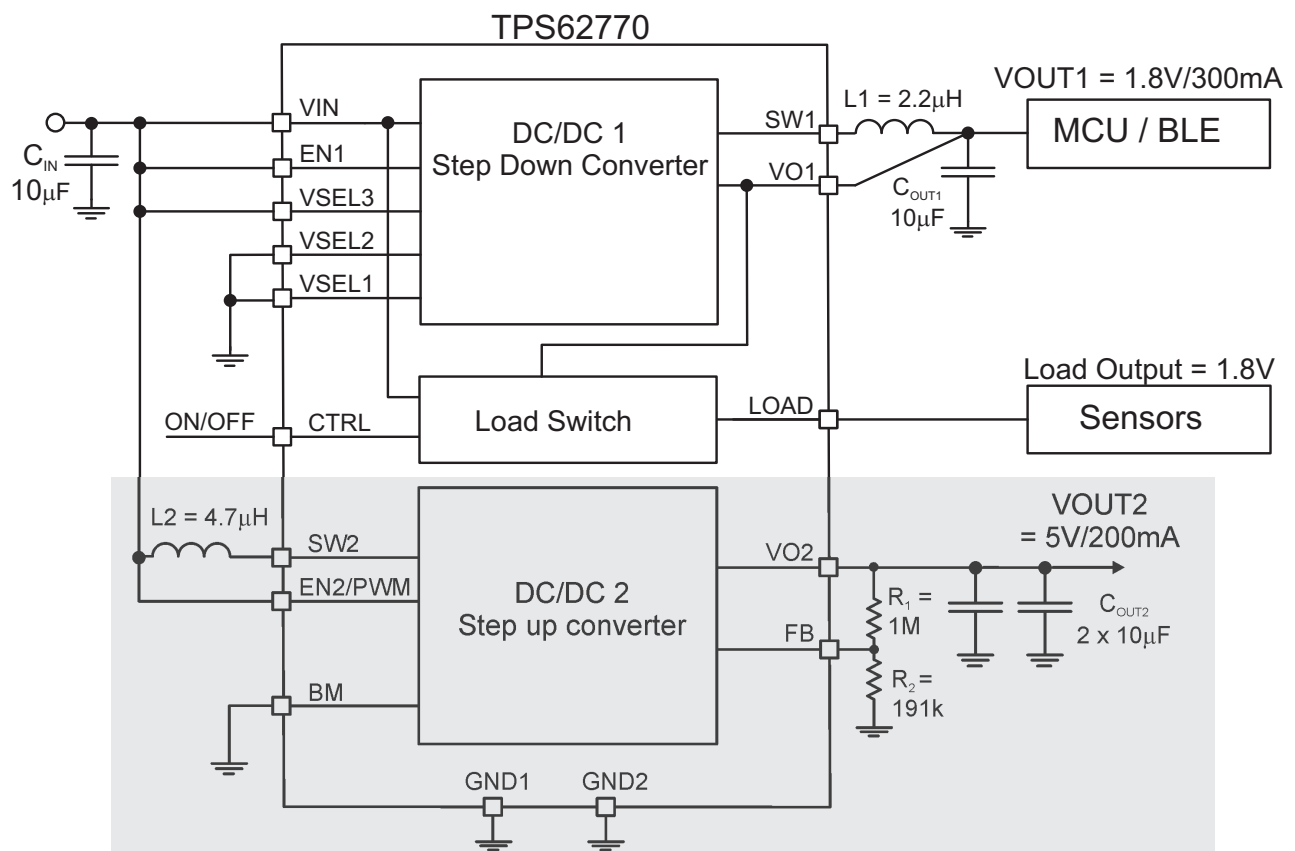### 8.2.2 Step-Up Converter with 5-V Output Voltage

图 36. Step-Up Converter Providing 5-V V$_{OUT2}$

8.2.2.1 Design Requirements

表 3. Components for Application Characteristic Curves

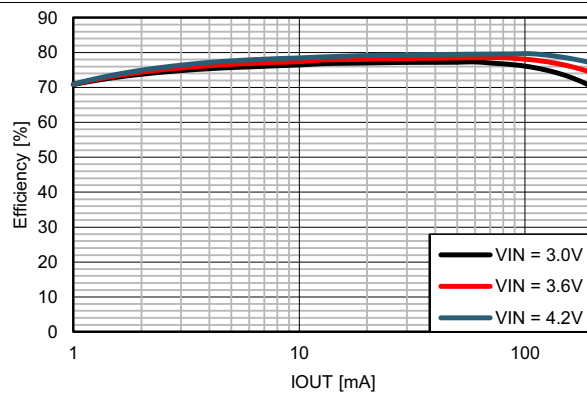| REFERENCE	DESCRIPTION	VALUE	PACKAGE CODE / SIZE [mm x mm x mm]	MANUFACTURER
CIN	Ceramic capacitor X5R 6.3V, GRM155R60J106ME11	10 µF	0402 / 1.0 x 0.5 x 0.5	Murata
COUT2 (2x)	Ceramic capacitor X5R 25V, GRM188R61E106MA73	10 uF	0603 / 1.6 x 0.8 x 0.8	Murata
L2	Inductor VLS302515	4.7 µH	3.0 x 2.5 x 1.5	TDK

8.2.2.2 Application Curves
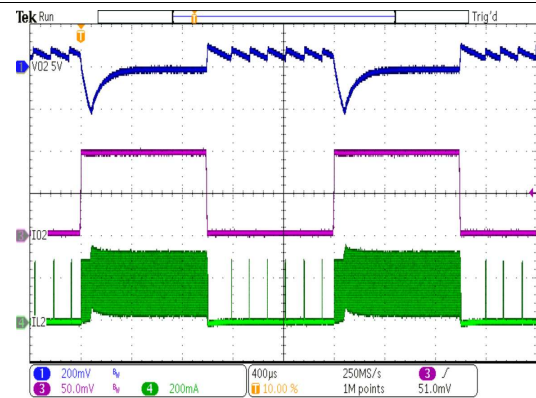

图 37. Efficiency vs. IOUT, VOUT = 5.0 V

图 38. Transient Response V_{OUT2} = 5 V

8.2.3 Step-Up Converter Operating with Constant Output Current

The step-up converter device can be configured to operate as a constant current driver e.g. to power 3 to 4 white LED's in a string. The current through the string is set by the sense resistor R_{Sense} as shown in 图 39 To minimize the losses in the sense resistor, the device features a 200mV internal reference. This section describes an application delivering 10mA through an LED string with 4 LED's which is suitable for small display used in wearable applications.
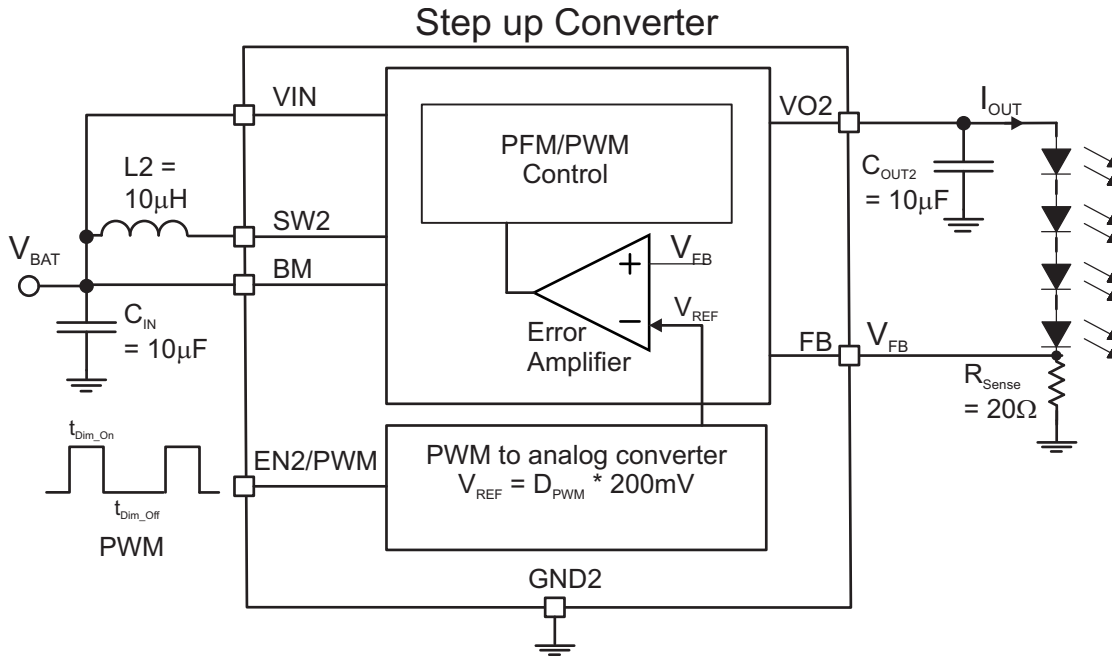

图 39. **Step-Up Converter with Constant Output Current - Simplified Block Diagram**

8.2.3.1 Design Requirements

The Sense resistor to set the maximum output current can be calculated according to 公式 3 The output current IOUT2 can be reduced by applying a PWM signal at pin EN2/PWM according to 公式 4

$$R_{Sense} = \frac{200\ mV}{I_{OUT2}} \tag{3}$$

$$I_{OUT2} = D_{PWM} \times \frac{200mV}{R_{Sense}} \tag{4}$$

Where:

R_{Sense} = sense resistor in [Ω]

I_{OUT2} = output current in [mA]

D_{PWM} = Dutycycle of the PWM singal at pin EN2/PWM

表 4. **Components for Application Characteristic Curves**

REFERENCE	DESCRIPTION	VALUE	PACKAGE CODE / SIZE [mm x mm x mm]	MANUFACTURER
CIN	Ceramic capacitor X5R 6.3V, GRM155R60J106ME11	10 µF	0402 / 1.0 x 0.5 x 0.5	Murata
COUT2	Ceramic capacitor X5R 25V, GRM188R61E106MA73	10 uF	0603 / 1.6 x 0.8 x 0.8	Murata
L2	Inductor VLS302515	10 µH	3.0 x 2.5 x 1.5	TDK
D1-D4	LED LTW-E670DS	n/a		Lite ON

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8.2.3.2 *Detailed Design Procedure*

8.2.3.2.1 Setting The Output Voltage Of The Step-Down Converter

The output voltage is set with the VSEL1-3 pins according to Table 1. No further external components are required.

8.2.3.2.2 Programming the Output Voltage Of The Step-Up Converter

There are two ways to set the output voltage of the step-up converter. When the FB pin is connected to the input voltage, the output voltage is fixed to 12 V. This function reduces the external components to minimize the solution size. The second way is to use an external resistor divider to set the desired output voltage.

By selecting the external resistor divider R1 and R2, as shown in 公式 5, the output voltage is programmed to the desired value. When the output voltage is regulated, the typical voltage at the FB pin is V_{REF} of 795 mV.

$$R1 = \left(\frac{V_{OUT}}{V_{REF}} - 1 \right) \times R2$$

(5)

Where:

V_{OUT} is the desired output voltage

V_{REF} is the internal reference voltage at the FB pin

8.2.3.2.3 Recommended LC Output Filter

表 5. **Recommended LC Output Filter Combinations for the Step-Down Converter**

INDUCTOR VALUE [μH][1]	OUTPUT CAPACITOR VALUE [μF][2]	
	10 μF	22 μF
2.2	√[3]	√

(1) Inductor tolerance and current de-rating is anticipated. The effective inductance can vary by 20% and -30%.
(2) Capacitance tolerance and bias voltage de-rating is anticipated. The effective capacitance can vary by 20% and -50%.
(3) This LC combination is the standard value and recommended for most applications.

表 6. **Recommended LC Output Filter Combinations for Step-Up Converter**

INDUCTOR VALUE [μH][1]	VOUT	IOUT	OUTPUT CAPACITOR VALUE [μF][2]	
			10 μF	2 x 10μF
10	9 V –15 V	(IOUT ≤ 30 mA)	√[3]	√
		(IOUT ≤ 100 mA)		√[3]
4.7	5 V	(IOUT ≤ 200 mA)		√[3]

(1) Inductor tolerance and current de-rating is anticipated. The effective inductance can vary by 20% and -30%.
(2) Capacitance tolerance and bias voltage de-rating is anticipated. The effective capacitance can vary by 20% and -50%.
(3) This LC combination is the standard value and recommended for most applications.

8.2.3.2.4 Inductor Selection Step-Down Converter

The inductor value affects its peak-to-peak ripple current, the PWM-to-PFM transition point, the output voltage ripple and the efficiency. The selected inductor has to be rated for its DC resistance and saturation current. The inductor ripple current (ΔI_L) decreases with higher inductance and increases with higher V_{IN} or V_{OUT} and can be estimated according to 公式 6.

公式 7 calculates the maximum inductor current under static load conditions. The saturation current of the inductor should be rated higher than the maximum inductor current, as calculated with 公式 7. This is recommended because during a heavy load transient the inductor current rises above the calculated value. A more conservative way is to select the inductor saturation current above the high-side MOSFET switch current limit, I_{LIMF}.

$$\Delta I_L = Vout \times \frac{1 - \dfrac{Vout}{Vin}}{L \times f} \tag{6}$$

$$I_{Lmax} = I_{outmax} + \frac{\Delta I_L}{2} \tag{7}$$

With:

    f = Switching Frequency

    L = Inductor Value

    ΔI_L = Peak to Peak inductor ripple current

    I_{Lmax} = Maximum Inductor current

In DC/DC converter applications, the efficiency is essentially affected by the inductor AC resistance (i.e. quality factor) and by the inductor DCR value. Increasing the inductor value produces lower RMS currents, but degrades transient response. For a given physical inductor size, increased inductance usually results in an inductor with lower saturation current.

The total losses of the coil consist of both the losses in the DC resistance (R_{DC}) and the following frequency-dependent components:

- The losses in the core material (magnetic hysteresis loss, especially at high switching frequencies)
- Additional losses in the conductor from the skin effect (current displacement at high frequencies)
- Magnetic field losses of the neighboring windings (proximity effect)
- Radiation losses

8.2.3.2.5 Inductor Selection Step-Up Converter

The step-up converter is optimized to work with an inductor values of 10 µH. Follow 公式 8 to 公式 10 to calculate the inductor's peak current for the application. To calculate the current in the worst case, use the minimum input voltage, maximum output voltage, and maximum load current of the application. To have enough design margin, choose the inductor value with -30% tolerance, and a low power-conversion efficiency for the calculation.

In a step-up regulator, the inductor dc current can be calculated with 公式 8.

$$I_{L(DC)} = \frac{V_{OUT} \times I_{OUT}}{V_{IN} \times \eta} \tag{8}$$

Where:

    V_{OUT} = output voltage

    I_{OUT} = output current

    V_{IN} = input voltage

    η = power conversion efficiency, use 80% for most applications

The inductor ripple current is calculated with the 公式 9 for an asynchronous step-up converter in continuous conduction mode (CCM).

$$\Delta I_{L(P-P)} = \frac{V_{IN} \times (V_{OUT} + 0.8V - V_{IN})}{L \times f_{SW} \times (V_{OUT} + 0.8V)} \tag{9}$$

Where:

    $\Delta I_{L(P-P)}$ = inductor ripple current

    L = inductor value

    f_{SW} = switching frequency

    V_{OUT} = output voltage

    V_{IN} = input voltage

Therefore, the inductor peak current is calculated with 公式 10.

$$I_{L(P)} = I_{L(DC)} + \frac{\Delta I_{L(P-P)}}{2}$$

(10)

The following inductor series from different suppliers have been used:

表 7. List Of Inductors

CONVERTER	INDUCTANCE [µH]	DIMENSIONS [mm³]	INDUCTOR TYPE	SUPPLIER[1]
Step-down	2.2	2.9 x 1.6 x 1.0	DFE201610C	TOKO
	2.2	2.0 x 1.25 x 1.0	MIPSZ2012D2R2	FDK
	2.2	2.0 x 1.2 x 1.0	MDT2012CH2R2	TOKO
Step-up	10	2.0x1.6x1.2	VLS201610	TDK
	10	3.0 x 2.5 x 1.5	VLS302515	TDK
	4.7	3.0 x 2.5 x 1.5	VLS302515	TDK
	4.7	2.0 x 1.6 x 1.5	VLS201612	TDK

(1)   See *Third-party Products Disclaimer*

8.2.3.2.6 DC/DC Input and Output Capacitor Selection

Ceramic capacitors with low ESR values have the lowest output voltage ripple and are recommended. The output capacitor requires either an X7R or X5R dielectric. Y5V and Z5U dielectric capacitors, aside from their wide variation in capacitance over temperature, become resistive at high frequencies. At light load currents, the converter operates in Power Save Mode and the output voltage ripple is dependent on the output capacitor value and the PFM peak inductor current. A 10 µF ceramic capacitor is recommended as input capacitor.

表 8 shows a list of tested input/output capacitors.

表 8. List Of Capacitors

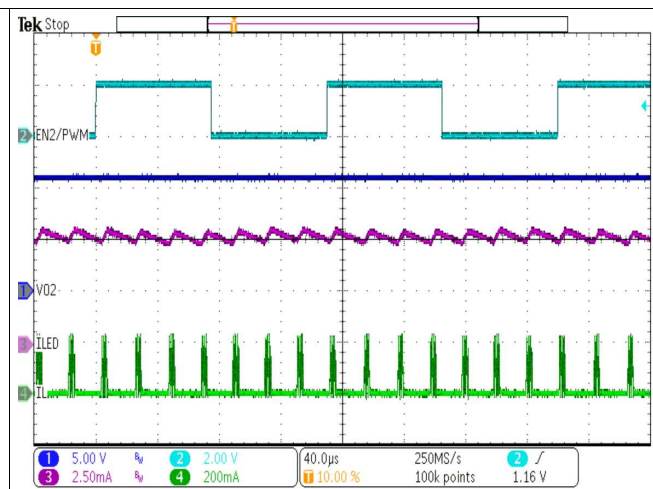| REFERENCE	DESCRIPTION	VALUE	PACKAGE CODE / SIZE [mm x mm x mm]	MANUFACTURER[1]
CIN	Ceramic capacitor X5R 6.3V, GRM155R60J106ME11	10µF	0402 / 1.0 x 0.5 x 0.5	Murata
COUT1	Ceramic capacitor X5R 6.3V, GRM155R60J106ME11	10µF	0402 / 1.0 x 0.5 x 0.5	Murata
COUT2	Ceramic capacitor X5R 25V, GRM188R61E106MA73	10uF	0603 / 1.6 x 0.8 x 0.8	Murata
	Ceramic capacitor X5R 6.3V, GRM188R60J106ME84	10uF	0603 / 1.6 x 0.8 x 0.8	Murata

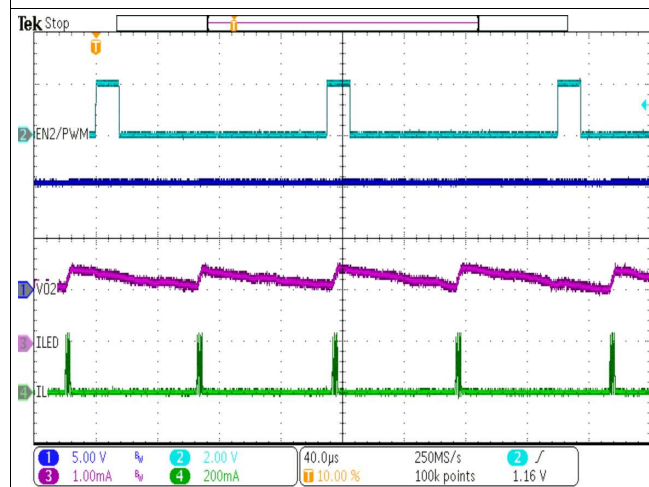(1)   See *Third-party Products Disclaimer*

8.2.3.3 *Application Curves*
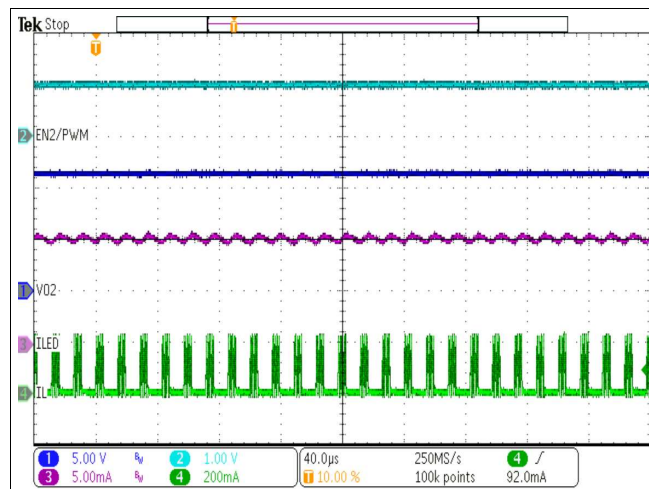
V_{IN} = 3.6V

EN2/PWM = high

D = 100%, I_{LED} = 10mA

R_{Sense}= 20Ω

4 LEDs in series

L = 10µH

图 40. Constant Current Operation with EN2/PWM = 100% D

V_{IN} = 3.6V

t_{Dim_On} = 75 µs, t_{Dim_Off} = 75µs

D = 50%, T_{Dlim} = 140µs, I_{LED} = 5mA

R_{Sense}= 20Ω

4 LED's in series

L = 10µH

图 41. Constant Current with EN2/PWM = 50% D

V_{IN} = 3.6V

t_{Dim_On} = 15 µs, t_{Dim_Off} = 135 µs

D = 10%, T_{Dlim} = 140 µs, I_{LED} = 1 mA

R_{Sense}= 20 Ω

4 LED's in series

L = 10 µH

图 42. Constant Current with EN2/PWM = 10% D

V_{IN} = 3.6V

T_{A} = 25°C

T_{Dlim} = 50 µs (F = 20kHz)
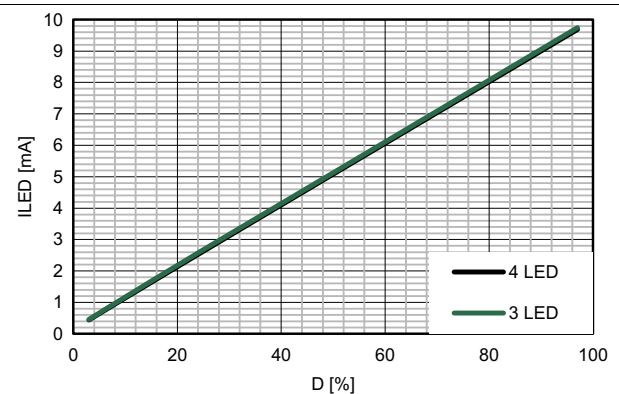
R_{Sense}= 20 Ω

LED's in string configuration

L = 10 µH

图 43. Constant Current vs D

9 Power Supply Recommendations

The power supply must provide a current rating according to the supply voltage, output voltage and output current of the TPS62770.

10 Layout

10.1 Layout Guidelines

- As for all switching power supplies, the layout is an important step in the design. Care must be taken in board layout to get the specified performance.
- If the layout is not carefully done, the regulator could show poor line and/or load regulation, stability issues as well as EMI problems and interference with RF circuits.
- It is critical to provide a low inductance, impedance ground path. Therefore, use wide and short traces for the main current paths.
- The input capacitor should be placed as close as possible to the IC pins VIN and GND. The output capacitors should be placed close between VO1/2 and GND pins.
- The VO1/2 line should be connected to the output capacitor and routed away from noisy components and traces (e.g. SW line) or other noise sources.
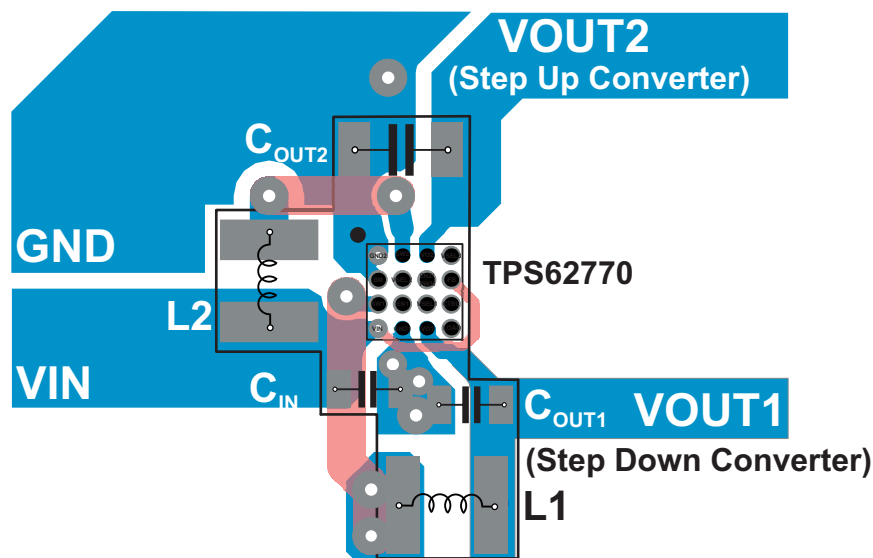- See 图 44 and 图 45 for the recommended PCB layout.

10.2 Layout Example

图 44. **Recommended PCB Layout with 12 V Fixed VOUT2**
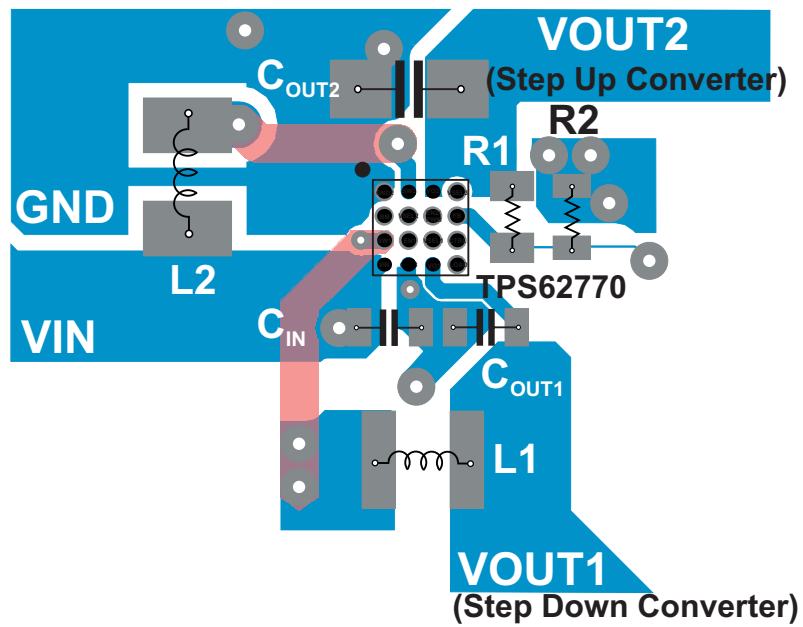
Layout Example (接下页)

图 45. **Recommended PCB Layout with Adjustable VOUT2**

11 器件和文档支持

11.1 器件支持

11.1.1 开发支持

11.1.1.1 *Third-Party Products Disclaimer*

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11.2 文档支持

11.2.1 相关文档

另请参见《*TPS62770EVM-734 评估模块用户指南*》（文献编号：SLVUAO2）和应用笔记《*精确测量超低 IQ 器件的效率*》（文献编号：SLYT558）。

11.3 商标

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11.4 静电放电警告

这些装置包含有限的内置 ESD 保护。 存储或装卸时，应将导线一起截短或将装置放置于导电泡棉中，以防止 MOS 门极遭受静电损伤。

11.5 Glossary

SLYZ022 — *TI Glossary*.

This glossary lists and explains terms, acronyms, and definitions.

12 机械、封装和可订购信息

以下页中包括机械、封装和可订购信息。这些信息是针对指定器件可提供的最新数据。这些数据会在无通知且不对本文档进行修订的情况下发生改变。欲获得该数据表的浏览器版本，请查阅左侧的导航栏。

PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package | Pins	Package qty | Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
TPS62770YFPR	Active	Production	DSBGA (YFP) | 16	3000 | LARGE T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 85	62770
TPS62770YFPR.B	Active	Production	DSBGA (YFP) | 16	3000 | LARGE T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 85	62770
TPS62770YFPT	Active	Production	DSBGA (YFP) | 16	250 | SMALL T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 85	62770
TPS62770YFPT.B	Active	Production	DSBGA (YFP) | 16	250 | SMALL T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 85	62770

(1) **Status:** For more details on status, see our product life cycle.

(2) **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

(3) **RoHS values:** Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

(4) **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

(5) **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.
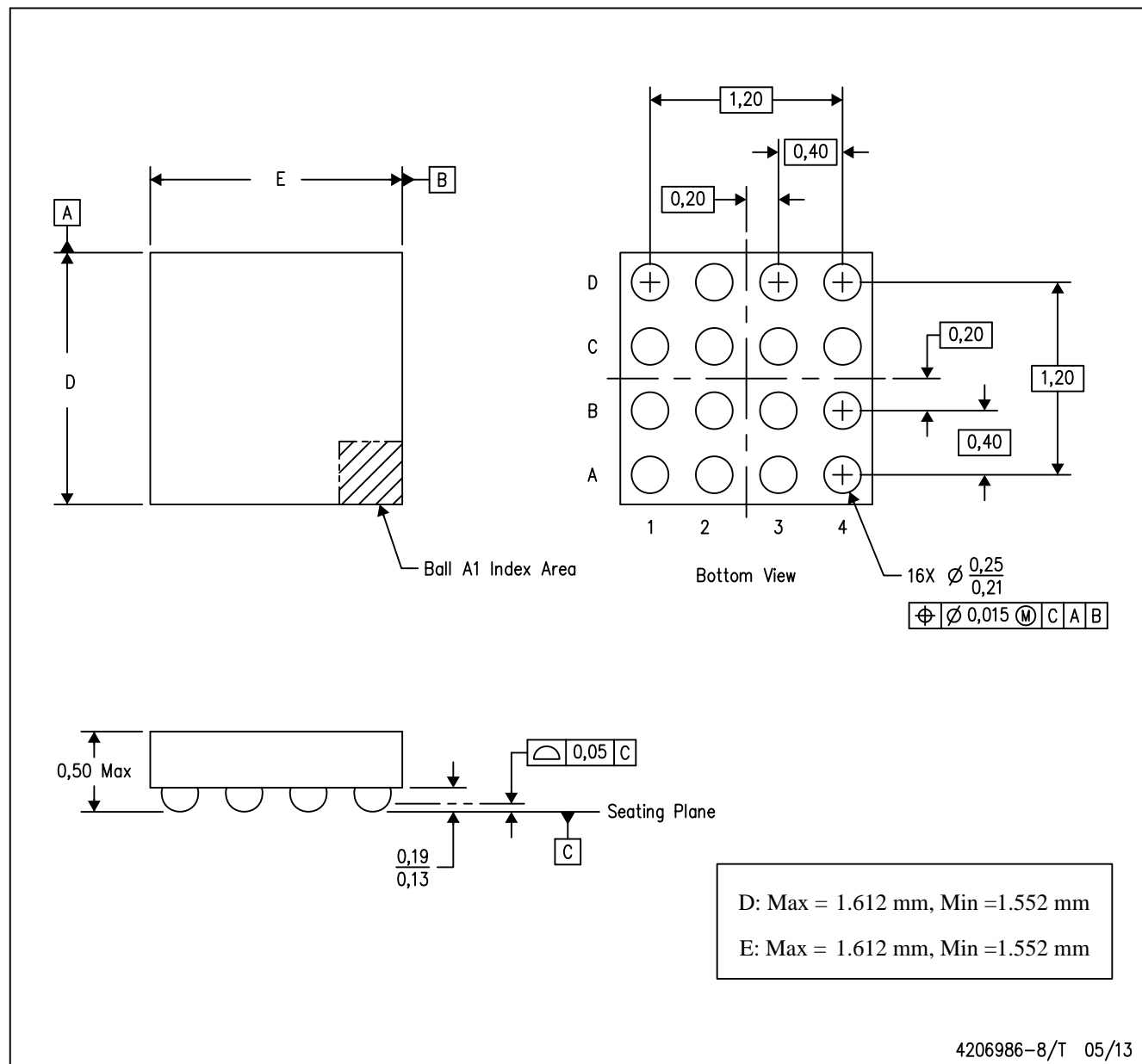
Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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YFP (S−XBGA−N16)   DIE−SIZE BALL GRID ARRAY

E

A

D

B

1,20

0,20

0,40

D
C
B
A

1   2   3   4

Bottom View

0,20

1,20

0,40

16X Ø $\frac{0,25}{0,21}$

⊕ Ø 0,015 Ⓜ C A B

Ball A1 Index Area

0,50 Max

0,05 C

Seating Plane

$\frac{0,19}{0,13}$

C

D: Max = 1.612 mm, Min =1.552 mm

E: Max = 1.612 mm, Min =1.552 mm

4206986−8/T 05/13

NOTES: A.   All linear dimensions are in millimeters.   Dimensioning and tolerancing per ASME Y14.5M−1994.
          B.   This drawing is subject to change without notice.
          C.   NanoFree™ package configuration.

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